





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

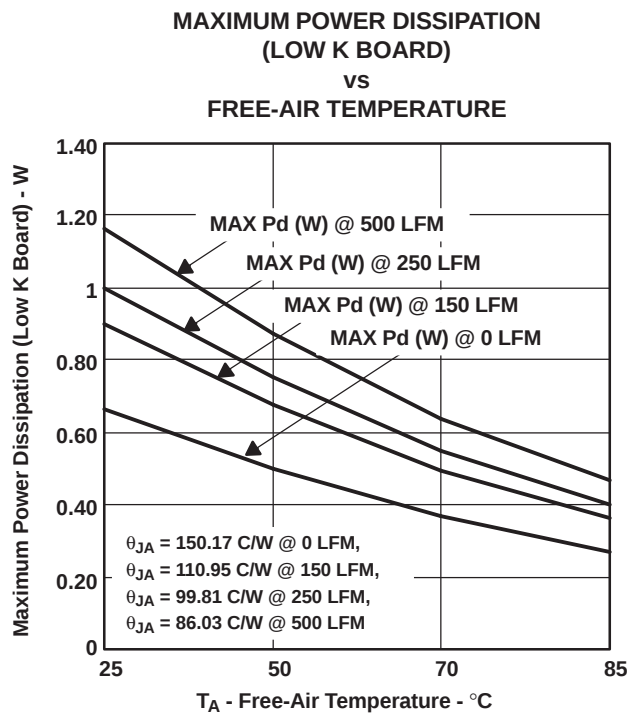
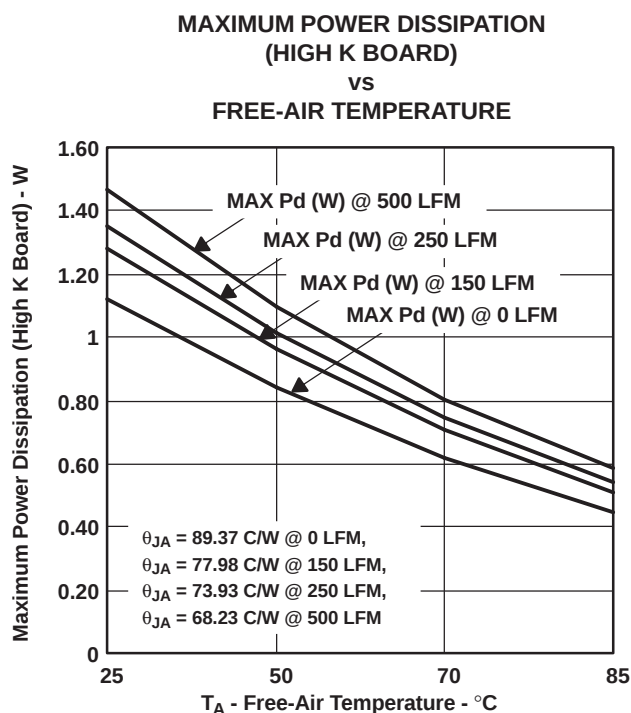
## DESCRIPTION (CONTINUED)

The battery voltage limit can be programmed by using the internal 1.196-V,  $\pm 0.5\%$  precision reference, making it suitable for the critical charging demands of lithium-ion cells. Also, the bq24702/bq24703 provides an option to override the precision reference and drive the error amplifier either directly from an external reference or from a resistor divider off the 5 V supplied by the integrated circuit.

The selector function allows the manual selection of the system power source, battery or wall-adaptor power. The bq24702/bq24703 supports battery-conditioning and battery-learn cycles through the ACSEL function. The ACSEL function allows manual selection of the battery or wall power as the main system power. It also provides autonomous switching to the remaining source (battery or ac power) should the selected system power source terminate (refer to Available Options table for the differences between the bq24702 and the bq24703). The bq24702/bq24703 also provides an alarm function to indicate a depleted battery condition.

The bq24702/bq24703 PWM controller is ideally suited for operation in a buck converter for applications when the wall-adaptor voltage is greater than the battery voltage.

## DISSIPATION RATINGS



- A. The JEDEC low K (1s) board design used to derive this data was a 3-inch  $\times$  3-inch, two layer board with 2 ounce copper traces on top of the board.
- B. The JEDEC high K (1s) board design used to derive this data was a 3-inch  $\times$  3-inch, multilayer board with 1 ounce internal power and ground planes and 2 ounce copper traces on top and bottom of the board.

### AVAILABLE OPTIONS

| CONDITION<br>20°C ≤ T <sub>J</sub> ≤ 125°C | SELECTOR OPERATION                                                       |                                                                |
|--------------------------------------------|--------------------------------------------------------------------------|----------------------------------------------------------------|
|                                            | bq24702PW                                                                | bq24703RHD                                                     |
| <b>BATTERY AS POWER SOURCE</b>             |                                                                          |                                                                |
| Battery removal                            | Automatically selects ac + alarm                                         | Automatically selects ac + alarm                               |
| Battery reinserted                         | Selection based on selector inputs                                       | Adapter latched until adapter is removed or ac select toggles. |
| <b>AC AS POWER SOURCE</b>                  |                                                                          |                                                                |
| AC removal                                 | Automatically selects battery                                            | Automatically selects battery                                  |
| AC reinserted                              | Selection based on selector inputs                                       | Selection based on selector inputs                             |
| <b>DEPLETED BATTERY CONDITION</b>          |                                                                          |                                                                |
| Battery as power source                    | Sends ALARM signal                                                       | <b>Automatically selects ac</b> Sends ALARM signal             |
| AC as power source                         | Sends ALARM signal                                                       | Sends ALARM signal                                             |
| <b>ALARM SIGNAL ACTIVE</b>                 |                                                                          |                                                                |
|                                            | Depleted battery condition                                               | Depleted battery condition                                     |
|                                            | When selector input is not equal to selector output (single pulse alarm) |                                                                |

### ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup> <sup>(2)</sup>

|                  |                                                                                                                                   | VALUE      | UNIT |
|------------------|-----------------------------------------------------------------------------------------------------------------------------------|------------|------|
| V <sub>CC</sub>  | Supply voltage range                                                                                                              | –0.3 to 30 | V    |
|                  | Battery voltage range: SRP, SRN                                                                                                   | –0.3 to 30 | V    |
|                  | Input voltage: ACN, ACP                                                                                                           | –0.3 to 30 | V    |
| T <sub>J</sub>   | Virtual junction temperature range                                                                                                | –40 to 125 | °C   |
|                  | Maximum source/sink current VHSP                                                                                                  | 50         | mA   |
|                  | Maximum ramp rate for V <sub>CC</sub>                                                                                             | 10         | V/μs |
|                  | Maximum sink current ACPRES, COMP, ALARM                                                                                          | 2.5        | mA   |
|                  | Maximum ramp rate for V <sub>(BAT)</sub>                                                                                          | 10         | V/μs |
|                  | Maximum source/sink current $\overline{\text{BATDRV}}$                                                                            | 10         | mA   |
|                  | Maximum source/sink current $\overline{\text{ACDRV}}$                                                                             | 10         | mA   |
|                  | Maximum source/sink current $\overline{\text{PWM}}$                                                                               | 50         | mA   |
|                  | Maximum source/sink current pulsed $\overline{\text{ACDRV}}$ , (10-μs rise time, 10-μs fall time, 1-ms pulse width, single pulse) | 50         | mA   |
|                  | Maximum source current VREF                                                                                                       | 30         | mA   |
|                  | Maximum source current SRP                                                                                                        | 100        | mA   |
|                  | Maximum difference voltage SRP–SRN                                                                                                | 30         | V    |
|                  |                                                                                                                                   |            |      |
| T <sub>stg</sub> | Storage temperature range                                                                                                         | –65 to 150 | °C   |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to ground. Currents are positive into and negative out of the specified terminals. Consult the *Packaging* section of the data book for thermal limitations and considerations of the package.

**RECOMMENDED OPERATING CONDITIONS**(T<sub>A</sub> = T<sub>OPR</sub>) all voltages relative to V<sub>SS</sub>

|                                                                                                            |                          | MIN  | MAX | UNIT |
|------------------------------------------------------------------------------------------------------------|--------------------------|------|-----|------|
| Supply voltage, (VCC)                                                                                      | Analog and PWM operation | 7    | 28  | V    |
|                                                                                                            | Selector operation       | 4.5  | 28  |      |
| Negative ac current sense, (ACN)                                                                           |                          | 7    | 28  | V    |
| Positive ac current sense, (ACP)                                                                           |                          | 7    | 28  | V    |
| Negative battery current sense, (SRN)                                                                      |                          | 5    | 28  | V    |
| Positive battery current sense, (SRP)                                                                      |                          | 5    | 28  | V    |
| AC or adapter power detection (ACDET)                                                                      |                          | 0    | 5   | V    |
| AC power indicator (ACPRES)                                                                                |                          | 0    | 5   | V    |
| AC adapter power select (ACSEL)                                                                            |                          | 0    | 5   | V    |
| Depleted battery level (BATDEP)                                                                            |                          | 0    | 5   | V    |
| Battery charge current programming voltage (SRSET)                                                         |                          | 0    | 2.5 | V    |
| Charge enable (ENABLE)                                                                                     |                          | 0    | 5   | V    |
| External override to an internal 0.5% precision reference (BATSET)                                         |                          | 0    | 2.5 | V    |
| Inverting input to the PWM comparator (COMP)                                                               |                          | 0    | 5   | V    |
| Battery charge regulation voltage measurement input to the battery—voltage g <sub>m</sub> amplifier (BATP) |                          | 0    | 5   | V    |
| Battery current differential amplifier output (IBAT)                                                       |                          | 0    | 5   | V    |
| System load voltage input pin (VS)                                                                         |                          | 0    | 2.5 | V    |
| Depleted battery alarm output (ALARM)                                                                      |                          | 0    | 5   | V    |
| Gate drive output ( $\overline{\text{PWM}}$ )                                                              |                          | VHSP | VCC | V    |
| Battery power source select output ( $\overline{\text{BATDRV}}$ )                                          |                          | 0    | 28  | V    |
| AC or adapter power source selection output ( $\overline{\text{ACDRV}}$ )                                  |                          | VHSP | VCC | V    |
| ACSET                                                                                                      |                          | 0    | 2.5 | V    |
| Operating free-air temperature, T <sub>A</sub>                                                             |                          | -40  | 85  | °C   |

## ELECTRICAL CHARACTERISTICS

–40°C ≤ T<sub>J</sub> ≤ 125°C, 7 V<sub>DC</sub> ≤ V<sub>CC</sub> ≤ 28 V<sub>DC</sub>, all voltages relative to V<sub>SS</sub> (unless otherwise specified)

| PARAMETER                                 |                                                                   | TEST CONDITIONS                                  | MIN  | TYP  | MAX  | UNIT |
|-------------------------------------------|-------------------------------------------------------------------|--------------------------------------------------|------|------|------|------|
| <b>QUIESCENT CURRENT</b>                  |                                                                   |                                                  |      |      |      |      |
| I <sub>DD(OP)</sub>                       | Total chip operating current                                      | ACPRES = High, EN = 0                            | 1    | 1.6  | 6    | mA   |
| I <sub>DD(SLEEP)</sub>                    | Total battery sleep current, ac not present                       | ACPRES = Low                                     |      | 22   | 28   | μA   |
| <b>LOGIC INTERFACE DC CHARACTERISTICS</b> |                                                                   |                                                  |      |      |      |      |
| V <sub>OL</sub>                           | Low-level output voltage (ACPRES, ALARM)                          | I <sub>OL</sub> = 1 mA                           |      |      | 0.4  | V    |
| V <sub>IL</sub>                           | Low-level input voltage (ACSEL, ENABLE)                           |                                                  |      |      | 0.6  | V    |
| V <sub>IH</sub>                           | High-level input voltage (ACSEL, ENABLE)                          |                                                  | 1.8  |      |      | V    |
| I <sub>(SINK1)</sub>                      | Sink current (ACPRES)                                             | V <sub>OL</sub> = 0.4                            | 1.5  | 2    | 2.5  | mA   |
| I <sub>(SINK2)</sub>                      | Sink current (ALARM)                                              | V <sub>OL</sub> = 0.4                            | 1.5  | 2    | 2.5  | mA   |
| <b>PWM OSCILLATOR</b>                     |                                                                   |                                                  |      |      |      |      |
| f <sub>OSC(PWM)</sub>                     | Oscillator frequency                                              | 0°C ≤ T <sub>J</sub> ≤ 85°C                      | 280  | 300  | 340  | kHz  |
|                                           |                                                                   | –40°C ≤ T <sub>J</sub> ≤ 125°C                   | 240  | 300  | 350  |      |
|                                           | Maximum duty cycle                                                |                                                  | 100% |      |      |      |
|                                           | Input voltage for maximum dc (COMP)                               |                                                  | 3.8  |      |      | V    |
|                                           | Minimum duty cycle                                                |                                                  |      |      | 0%   |      |
|                                           | Input voltage for minimum dc (COMP)                               |                                                  |      |      | 0.8  | V    |
| V <sub>(RAMP)</sub>                       | Oscillator ramp voltage (peak-to-peak)                            |                                                  | 1.85 | 2.15 | 2.30 |      |
| V <sub>IK(COMP)</sub>                     | Internal input clamp voltage (tracks COMP voltage for maximum dc) |                                                  |      | 3.8  | 4.5  |      |
| I <sub>S(COMP)</sub>                      | Internal source current (COMP)                                    | Error amplifier = OFF, V <sub>(COMP)</sub> = 1 V | 70   | 110  | 140  | μA   |
| <b>LEAKAGE CURRENT</b>                    |                                                                   |                                                  |      |      |      |      |
| I <sub>L(ACDET)</sub>                     | Leakage current, ACDET                                            | V <sub>(ACDET)</sub> = 5 V                       |      |      | 0.2  | μA   |
| I <sub>L(SRSET)</sub>                     | Leakage current, SRSET                                            | V <sub>(SRSET)</sub> = 2.5 V                     |      |      | 0.2  | μA   |
| I <sub>L(ACSET)</sub>                     | Leakage current, ACSET                                            | V <sub>(ACSET)</sub> = 2.5 V                     |      |      | 0.2  | μA   |
| I <sub>L(BATDEP)</sub>                    | Leakage current, BATDEP                                           | V <sub>(BATDEP)</sub> = 5 V                      |      |      | 0.2  | μA   |
| I <sub>L(VS)</sub>                        | Leakage current, VS                                               | V <sub>(VS)</sub> = 5 V                          |      |      | 0.2  | μA   |
| I <sub>L(ALARM)</sub>                     | Leakage current, ALARM                                            | V <sub>(ALARM)</sub> = 5 V                       |      |      | 0.2  | μA   |
| I <sub>L(ACSEL)</sub>                     | Leakage current, ACSEL                                            | V <sub>(ACSEL)</sub> = 5 V                       |      |      | 0.2  | μA   |
| I <sub>L(ENABLE)</sub>                    | Leakage current, ENABLE                                           | V <sub>(ENABLE)</sub> = 5 V                      |      |      | 0.2  | μA   |
| I <sub>L(ACPRES)</sub>                    | Leakage current, ACPRES                                           | V <sub>(ACPRES)</sub> = 5 V                      |      |      | 0.2  | μA   |
| I <sub>L(BATP)</sub>                      | Leakage current, BATP                                             | V <sub>(BATP)</sub> = 5 V                        |      |      | 0.2  | μA   |
| I <sub>L(BATSET)</sub>                    | Leakage current, BATSET                                           | V <sub>(BATSET)</sub> = 2.5 V                    |      |      | 0.2  | μA   |

**ELECTRICAL CHARACTERISTICS (Continued)**–40°C ≤ T<sub>J</sub> ≤ 125°C, 7 V<sub>DC</sub> ≤ V<sub>CC</sub> ≤ 28 V<sub>DC</sub>, all voltages relative to V<sub>SS</sub> (unless otherwise specified)

| PARAMETER                                       |                                                                    | TEST CONDITIONS                                                                         | MIN | TYP | MAX | UNIT |
|-------------------------------------------------|--------------------------------------------------------------------|-----------------------------------------------------------------------------------------|-----|-----|-----|------|
| <b>BATTERY CURRENT-SENSE AMPLIFIER</b>          |                                                                    |                                                                                         |     |     |     |      |
| g <sub>m</sub>                                  | Transconductance gain                                              |                                                                                         | 75  | 120 | 175 | mA/V |
| CMRR                                            | Common-mode rejection ratio                                        | See <sup>(1)</sup>                                                                      |     | 90  |     | dB   |
| V <sub>ICR</sub>                                | Common-mode input (SRP, SRN) voltage range                         | V <sub>CC</sub> = SRN, SRP + 2 V                                                        | 5   |     | 30  | V    |
| I <sub>(SINK)</sub>                             | Sink current (COMP)                                                | COMP = 1 V, (SRP–SRN) = 10 mV                                                           | 0.5 | 1.5 | 2.5 | mA   |
| I <sub>IB</sub>                                 | Input bias current (SRP) <sup>(2)</sup>                            | V <sub>(SRP)</sub> = 16 V, (SRP–SRN) = 100 mV, SRSET = 2.5 V, V <sub>CC</sub> = 28      | 70  | 85  | 110 | μA   |
|                                                 | Input bias current accuracy (I <sub>SRP</sub> – I <sub>SRN</sub> ) | (SRP – SRN) = 100 mV, SRSET = 2.5 V, V <sub>CC</sub> = 28 V, 0 ≤ T <sub>J</sub> ≤ 125°C | –3  | 0   | 3   |      |
| V <sub>(SET)</sub>                              | Battery current programming voltage (SRSET)                        |                                                                                         | 0   |     | 2.5 | V    |
| A <sub>V</sub>                                  | Battery current set gain                                           | 0.65 V ≤ SRSET ≤ 2.5 V, 8 V ≤ SRN ≤ 16 V <sup>(3)</sup>                                 | 24  | 25  | 26  | V/V  |
| Total battery current-sense mid-scale accuracy  |                                                                    | SRSET = 1.25 V, T <sub>J</sub> = 25°C <sup>(4)</sup>                                    | –5% |     | 5%  |      |
|                                                 |                                                                    | SRSET = 1.25 V <sup>(4)</sup>                                                           | –6% |     | 6%  |      |
| Total battery current-sense full-scale accuracy |                                                                    | SRSET = 2.5 V, T <sub>J</sub> = 25°C <sup>(4)</sup>                                     | –3% |     | 3%  |      |
|                                                 |                                                                    | SRSET = 2.5 V <sup>(4)</sup>                                                            | –4% |     | 4%  |      |

(1) Specified by design. Not production tested.

(2) I<sub>(SRP)</sub> = I<sub>(SRN)</sub> = (V<sub>(SRSET)</sub> / 50 kΩ) + ((V<sub>(SRP)</sub> – V<sub>(SRN)</sub>) / 3 kΩ)  
example: If (V<sub>(SRSET)</sub> = 2.5 V), (V<sub>(SRP)</sub> – V<sub>(SRN)</sub>) = 100 mV Then I<sub>(SRP)</sub> = I<sub>(SRN)</sub> = 83 A(3)  $I_{BAT} = \frac{SRSET}{R_{SENSE}} \times \frac{1}{A_V}$ 

(4) Total battery-current set is based on the measured value of (SRP–SRN) = Δm, and the calculated value of (SRP–SRN) = Δc, using the

$$\Delta c = \frac{SRSET}{A_V}, \text{ Total accuracy in \%} = \frac{(\Delta m - \Delta c)}{\Delta c} \times 100, I_{(SRP)} - I_{(SRN)} = 0$$

measured gain, A<sub>V</sub>.

## ELECTRICAL CHARACTERISTICS (Continued)

–40°C ≤ T<sub>J</sub> ≤ 125°C, 7 V<sub>DC</sub> ≤ V<sub>CC</sub> ≤ 28 V<sub>DC</sub>, all voltages relative to V<sub>SS</sub>, (unless otherwise specified)

| PARAMETER                                  |                                                                              | TEST CONDITIONS                                                                     | MIN   | TYP   | MAX             | UNIT |
|--------------------------------------------|------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|-------|-------|-----------------|------|
| <b>ADAPTER CURRENT-SENSE AMPLIFIER</b>     |                                                                              |                                                                                     |       |       |                 |      |
| g <sub>m</sub>                             | Transconductance gain                                                        |                                                                                     | 75    | 130   | 175             | mA/V |
| CMRR                                       | Common-mode rejection ratio                                                  | See <sup>(1)</sup>                                                                  |       | 90    |                 | dB   |
| V <sub>ICR</sub>                           | Common-mode input voltage range (ACP)                                        |                                                                                     | 7     |       | V <sub>CC</sub> | V    |
| I <sub>(SINK)</sub>                        | Sink current (COMP)                                                          | COMP = 1 V, (ACP – ACN) = 10 mV                                                     | 0.5   | 1.5   | 2.5             | mA   |
| I <sub>IB</sub>                            | Input bias current (ACP, ACN)                                                | ACP = ACN = 28 V, V <sub>CC</sub> = 28 V, ACSET = 2.5 V                             | 40    | 50    | 65              | A    |
|                                            | Input bias current accuracy ratio (I <sub>(ACP)</sub> , I <sub>(ACN)</sub> ) | ACP = ACN = 28 V, V <sub>CC</sub> = 28 V, ACSET = 2.5 V, 0 ≤ T <sub>J</sub> ≤ 125°C | –3    | 0     | 3               |      |
| V <sub>(SET)</sub>                         | AC current programming voltage (ACSET)                                       |                                                                                     | 0     |       | 2.5             | V    |
| A <sub>V</sub>                             | AC current set gain                                                          | 0.65 V ≤ ACSET ≤ 2.5 V, 12 V ≤ ACP ≤ 20 V <sup>(1)</sup>                            | 24.5  | 25.3  | 26.5            | V/V  |
| Total ac current-sense mid-scale accuracy  |                                                                              | ACSET = 1.25 V, T <sub>J</sub> = 25°C <sup>(2)</sup>                                | –5%   |       | 5%              |      |
|                                            |                                                                              | ACSET = 1.25 V <sup>(2)</sup>                                                       | –6%   |       | 6%              |      |
| Total ac current-sense full-scale accuracy |                                                                              | ACSET = 2.5 V, T <sub>J</sub> = 25°C <sup>(2)</sup>                                 | –3.5% |       | 3.5%            |      |
|                                            |                                                                              | ACSET = 2.5 V <sup>(2)</sup>                                                        | –4%   |       | 4%              |      |
| <b>BATTERY VOLTAGE ERROR AMPLIFIER</b>     |                                                                              |                                                                                     |       |       |                 |      |
| g <sub>m</sub>                             | Transconductance gain                                                        |                                                                                     | 75    | 135   | 175             | mA/V |
| CMRR                                       | Common-mode rejection ratio                                                  | See <sup>(1)</sup>                                                                  |       | 90    |                 | dB   |
| V <sub>ICR</sub>                           | BATSET common-mode input voltage range                                       |                                                                                     | 1     |       | 2.5             | V    |
| V <sub>IT</sub>                            | Internal reference override input threshold voltage                          |                                                                                     | 0.20  | 0.25  | 0.35            | V    |
| I <sub>(SINK)</sub>                        | Sink current COMP                                                            | COMP = 1 V, (BATP–BATSET) = 10 mV, BATSET = 1.25 V                                  | 0.5   | 1.5   | 2.5             | mA   |
| V <sub>(FB)</sub>                          | Error-amplifier precision reference voltage                                  | T <sub>J</sub> = 25°C                                                               | 1.190 | 1.196 | 1.202           | V    |
|                                            |                                                                              | T <sub>J</sub> = 0°C to 85°C                                                        | 1.183 | 1.196 | 1.203           |      |
|                                            |                                                                              | T <sub>J</sub> = –40°C to 125°C                                                     | 1.178 | 1.196 | 1.204           |      |

- (1) Calculation of the ac current:  $I_{AC} = \frac{ACSET}{R_{SENSE}} \times \frac{1}{A_V}$
- (2) Total ac-current set accuracy is based on the measured value of (ACP–ACN) = Δc, using the measured gain, A<sub>V</sub>.
- $\Delta c = \frac{ACSET}{A_V}$ , Total accuracy in % =  $\frac{(\Delta m - \Delta c)}{\Delta c} \times 100$ , I<sub>(ACP)</sub> – I<sub>(ACN)</sub> = 0

**ELECTRICAL CHARACTERISTICS (Continued)**–40°C ≤ T<sub>J</sub> ≤ 125°C, 7 V<sub>DC</sub> ≤ V<sub>CC</sub> ≤ 28 V<sub>DC</sub>, all voltages relative to V<sub>SS</sub> (unless otherwise specified)

| PARAMETER                                          |                                                | TEST CONDITIONS                                                             | MIN                  | TYP                    | MAX                   | UNIT  |
|----------------------------------------------------|------------------------------------------------|-----------------------------------------------------------------------------|----------------------|------------------------|-----------------------|-------|
| BATTERY CURRENT OUTPUT AMPLIFIER                   |                                                |                                                                             |                      |                        |                       |       |
| G <sub>(TR)</sub>                                  | Transfer gain                                  | (SRP–SRN) = 5 mV <sup>(1)</sup>                                             |                      | 20                     |                       | V/V   |
| V <sub>I(BAT)</sub>                                | Battery current readback output voltage (IBAT) | (SRP–SRN) = 5 mV, SRP = 12 V, V <sub>CC</sub> = 18 V, T <sub>J</sub> = 25°C |                      | 100                    |                       | mV    |
|                                                    | Line rejection voltage                         | T <sub>J</sub> = 25°C                                                       |                      | 10                     |                       | mV/V  |
| CM                                                 | Common-mode input range (SRP)                  |                                                                             | 5                    |                        | 28                    | V     |
| V <sub>O(IBAT)</sub>                               | Battery current output voltage range (IBAT)    |                                                                             | 0                    |                        | 2.5                   | V     |
| I <sub>S(O)</sub>                                  | Output source current (IBAT)                   | (SRP–SRN) = 100 mV                                                          | 5                    | 7.1                    | 9.4                   | mA    |
| Total battery current readback full-scale accuracy |                                                | (SRP–SRN) = 50 mV, T <sub>J</sub> = 25°C <sup>(1)</sup>                     | –3%                  |                        | 2.4%                  |       |
|                                                    |                                                | (SRP–SRN) = 50 mV, 0°C ≤ T <sub>J</sub> ≤ 85°C                              | –20%                 |                        | 20%                   |       |
|                                                    |                                                | (SRP–SRN) = 100 mV, T <sub>J</sub> = 25°C <sup>(1)</sup>                    | –1.5%                |                        | 1.2%                  |       |
|                                                    |                                                | (SRP–SRN) = 100 mV, 0°C < T <sub>J</sub> < 85°C                             | –6%                  |                        | 8.5%                  |       |
| 5-V VOLTAGE REFERENCE                              |                                                |                                                                             |                      |                        |                       |       |
| V <sub>ref</sub>                                   | Output voltage (VREF)                          | T <sub>J</sub> = 25°C                                                       | 4.985                | 5                      | 5.013                 | V     |
|                                                    |                                                | T <sub>J</sub> = 0°C to 85°C                                                | 4.946                | 5                      | 5.013                 |       |
|                                                    |                                                | T <sub>J</sub> = 40°C to 85°C                                               | 4.946                | 5                      | 5.03                  | V     |
|                                                    |                                                | T <sub>J</sub> = –40°C to 125°C                                             | 4.926                | 5                      | 5.03                  | V     |
|                                                    | Line regulation                                | I <sub>LOAD</sub> = 5 mA                                                    |                      | 0.1                    | 0.37                  | mV/V  |
|                                                    | Load regulation                                | 1 mA ≤ I <sub>LOAD</sub> ≤ 5 mA                                             |                      | 1.1                    | 4                     | mV/mA |
|                                                    | Short circuit current                          |                                                                             | 8                    | 20                     | 30                    | mA    |
|                                                    | 5V REF output capacitor                        | Capacitance                                                                 | 2.2                  |                        | 10                    | μF    |
|                                                    | Output capacitor equivalent resistor           | ESR                                                                         | 5                    |                        | 1000                  | mΩ    |
| HALF SUPPLY REGULATOR                              |                                                |                                                                             |                      |                        |                       |       |
| V <sub>(HSP)</sub>                                 | Voltage regulation                             | I <sub>(SINK)</sub> = 20 mA, V <sub>CC</sub> = 18 V                         | V <sub>CC</sub> – 11 | V <sub>CC</sub> – 10.2 | V <sub>CC</sub> – 8.5 | V     |
|                                                    |                                                | I <sub>(SINK)</sub> = 1 mA, V <sub>CC</sub> = 7 V                           |                      |                        | 1.5                   |       |

(1) Battery readback transfer gain  $G_{TR} = \frac{V_{IBAT}}{(SRP - SRN)}$

## ELECTRICAL CHARACTERISTICS (Continued)

–40°C ≤ T<sub>J</sub> ≤ 125°C, 7 V<sub>DC</sub> ≤ V<sub>CC</sub> ≤ 28 V<sub>DC</sub>, all voltages relative to V<sub>SS</sub> (unless otherwise specified)

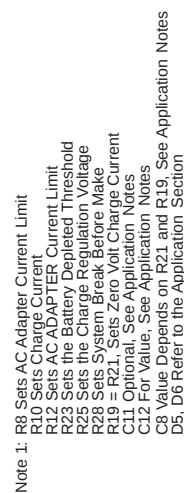
| PARAMETER                          |                                                    | TEST CONDITIONS                                                        | MIN                   | TYP                   | MAX                   | UNIT |
|------------------------------------|----------------------------------------------------|------------------------------------------------------------------------|-----------------------|-----------------------|-----------------------|------|
| MOSFET GATE DRIVE                  |                                                    |                                                                        |                       |                       |                       |      |
|                                    | AC driver R <sub>DS(on)</sub> high                 | V <sub>CC</sub> = 18 V, I <sub>(ACDRV)</sub> = 1 mA                    |                       | 85                    | 150                   | Ω    |
|                                    | AC driver R <sub>DS(on)</sub> low                  | V <sub>CC</sub> = 18 V, I <sub>(ACDRV)</sub> = 1 mA                    |                       | 55                    | 110                   | Ω    |
|                                    | Battery driver R <sub>DS(on)</sub> high            | V <sub>CC</sub> = 18 V, I <sub>(BATDRV)</sub> = 1 mA                   |                       | 315                   | 600                   | Ω    |
|                                    | Battery driver R <sub>DS(on)</sub> low             | V <sub>CC</sub> = 18 V, I <sub>(BATDRV)</sub> = 1 mA                   |                       | 70                    | 115                   | Ω    |
| t <sub>da</sub>                    | Time delay from ac driver off to battery driver on | ACSEL 2.4 V ^ 0.2 V                                                    |                       | 1.2                   | 2                     | μs   |
| t <sub>db</sub>                    | Time delay from battery driver off to ac driver on | ACSEL 0.2 V \$ 2.4 V                                                   |                       | 2.4                   | 3.3                   | μs   |
| V <sub>OH</sub>                    | PWM driver high-level output voltage               | I <sub>O</sub> = –10 mA, V <sub>CC</sub> = 18 V                        | V <sub>CC</sub> –0.18 | V <sub>CC</sub> –0.09 |                       | V    |
|                                    |                                                    | I <sub>O</sub> = –50 mA, V <sub>CC</sub> = 18 V                        | V <sub>CC</sub> –1.2  | V <sub>CC</sub> –0.8  |                       |      |
|                                    | PWM driver R <sub>DS(on)</sub> high                |                                                                        |                       | 7                     | 14                    | Ω    |
| V <sub>OL</sub>                    | PWM driver low-level output voltage                | I <sub>O</sub> = 10 mA, V <sub>CC</sub> = 18 V                         |                       | V <sub>HSP</sub> +0.1 | V <sub>HSP</sub> +0.4 | V    |
|                                    |                                                    | I <sub>O</sub> = 50 mA, V <sub>CC</sub> = 18 V                         |                       | V <sub>HSP</sub> +0.6 | V <sub>HSP</sub> +1.2 |      |
|                                    | PWM driver R <sub>DS(on)</sub> low                 |                                                                        |                       | 5                     | 8.5                   | Ω    |
| SELECTOR                           |                                                    |                                                                        |                       |                       |                       |      |
| V <sub>(ACPRES)</sub>              | AC presence detect voltage                         |                                                                        | 1.194                 | 1.246                 | 1.286                 | V    |
|                                    |                                                    | –40°C to 85°C                                                          | 1.208                 | 1.246                 | 1.285                 |      |
| V <sub>IT(ACPRES)</sub>            | AC presence hysteresis                             |                                                                        |                       | 1%                    |                       |      |
| t <sub>d(ACPRES)</sub>             | Deglitch delay for adapter insertion               |                                                                        |                       | 100                   |                       | μs   |
| V <sub>(BATDEP)</sub>              | Battery depletion ALARM trip voltage               | See <sup>(1)</sup>                                                     | 1.194                 | 1.246                 | 1.286                 | V    |
|                                    |                                                    | –40°C to 85°C                                                          | 1.208                 | 1.246                 | 1.285                 |      |
| V <sub>(NOBAT)</sub>               | No battery detect, switch to ACDRV                 | bq24702 only <sup>(1)</sup>                                            | 0.869                 | 1                     | 1.144                 | V    |
|                                    |                                                    | –40°C to 85°C                                                          | 0.880                 | 1                     | 1.118                 |      |
| t <sub>(BATSEL)</sub>              | Battery select time (ACSEL low to BATDRV low)      | VS < BATP, 50% threshold, ACSEL 2.4 V ↓ 0.2 V                          | 1                     | 2.5                   | 3.5                   | μs   |
| t <sub>(ACSEL)</sub>               | AC select time (ACSEL high to ACDRV low)           | ACSEL 0.2 V ↑ 2.4 V                                                    | 1                     | 2.5                   | 5                     | μs   |
| V <sub>(VS)</sub>                  | VS voltage to enable BATDRV                        | BATP = 1 V                                                             | 0.98                  | 1                     | 1.02                  | V    |
| V <sub>IT(VS)</sub>                | VS voltage hysteresis                              | VS > BATP                                                              | 20                    | 35                    | 85                    | mV   |
| ZERO VOLT OPERATION <sup>(2)</sup> |                                                    |                                                                        |                       |                       |                       |      |
| r <sub>DS(on)</sub>                | Static drain source on-state resistance            | V <sub>CC</sub> = 7 V, T <sub>J</sub> = 125°C, I <sub>O</sub> = 100 mA |                       | 5.3                   | 8.7                   | Ω    |
|                                    | Zero volt operation threshold                      | BATDEP increasing                                                      | 0.743                 | 0.794                 | 0.840                 | V    |
|                                    |                                                    | BATDEP decreasing                                                      | 0.570                 | 0.62                  | 0.656                 |      |

(1) Total battery current readback accuracy is based on the measured value of V<sub>IBAT</sub>, V<sub>IBATm</sub>, and the calculated value of V<sub>IBAT</sub>, V<sub>IBATc</sub>, using the measured value of the transfer gain, GTR.

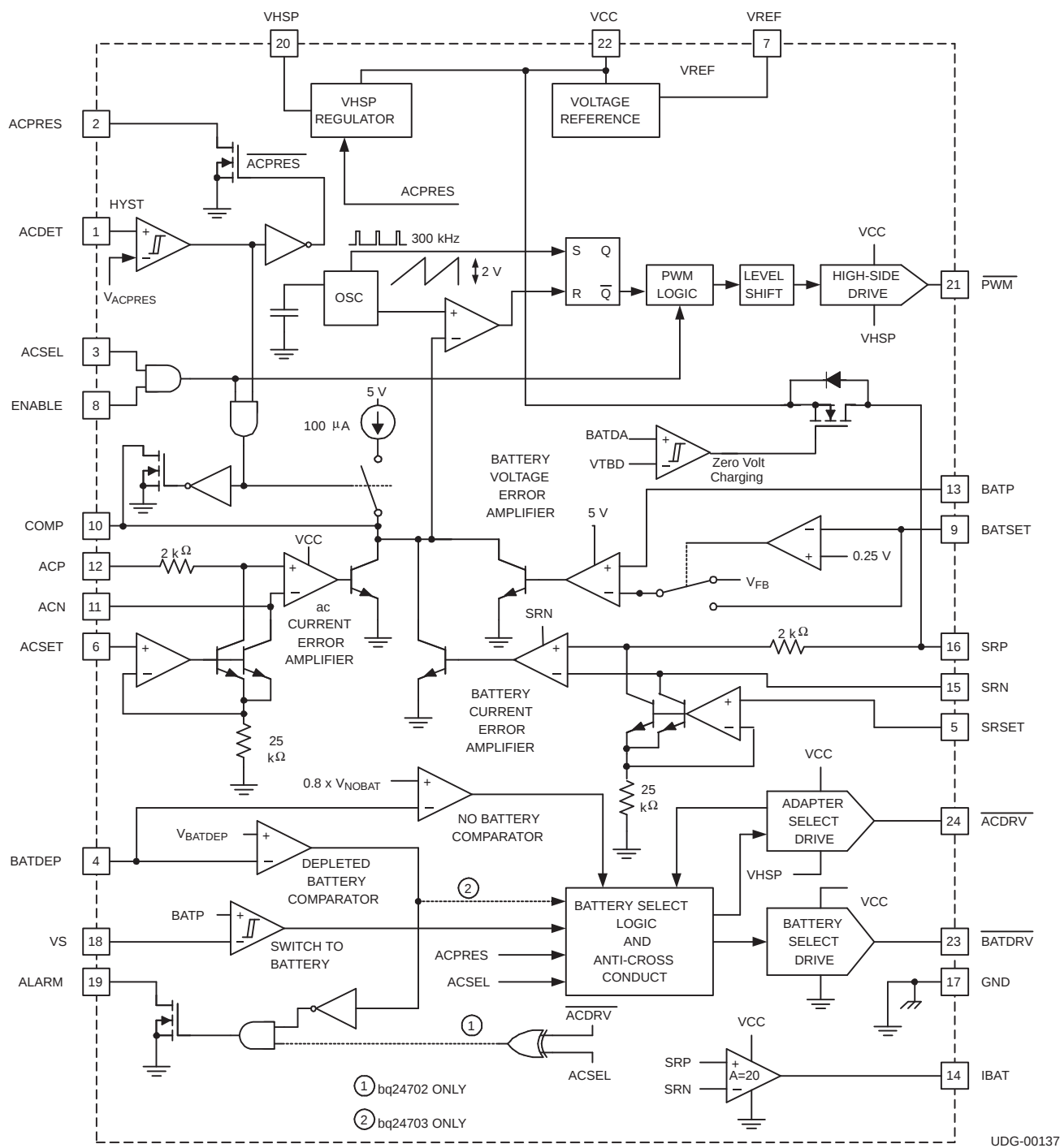
$$V_{IBATc} = (SRP - SRN) \times GTR \quad \text{Total Accuracy in \%} = \frac{V_{IBATm} - V_{IBATc}}{V_{IBATm}} \times 100$$

(2) See [Table 1](#) to determine the logic operation of the bq24702 and the bq24703.

## APPLICATION DIAGRAM



## BLOCK DIAGRAM



**Table 1. TERMINAL FUNCTIONS**

| TERMINAL                   |                 |                  | I/O | DESCRIPTION                                                                                |
|----------------------------|-----------------|------------------|-----|--------------------------------------------------------------------------------------------|
| NAME                       | bq24702<br>(PW) | bq24703<br>(QFN) |     |                                                                                            |
| ACDET                      | 1               | 26               | I   | AC or adapter power detection                                                              |
| $\overline{\text{ACDRV}}$  | 24              | 25               | O   | AC or adapter power source selection output                                                |
| ACN                        | 11              | 8                | I   | Negative differential input                                                                |
| ACP                        | 12              | 9                | I   | Positive differential input                                                                |
| ACPRES                     | 2               | 27               | O   | AC power indicator                                                                         |
| ACSEL                      | 3               | 28               | I   | AC adapter power select                                                                    |
| ACSET                      | 6               | 3                | I   | Adapter current programming voltage                                                        |
| ALARM                      | 19              | 19               | O   | Alarm output                                                                               |
| BATDEP                     | 4               | 1                | I   | Depleted battery level                                                                     |
| $\overline{\text{BATDRV}}$ | 23              | 24               | O   | Battery power source select output                                                         |
| BATP                       | 13              | 12               | I   | Battery charge regulation voltage measurement input to the battery-voltage $g_m$ amplifier |
| BATSET                     | 9               | 6                | I   | External override to an internal precision reference                                       |
| COMP                       | 10              | 7                | O   | Inverting input to the PWM comparator                                                      |
| ENABLE                     | 8               | 5                | I   | Charge enable                                                                              |
| GND                        | 17              | 17               | O   | Supply return and ground reference                                                         |
| IBAT                       | 14              | 13               | O   | Battery current differential amplifier output                                              |
| $\overline{\text{PWM}}$    | 21              | 21               | O   | Gate drive output                                                                          |
| SRN                        | 15              | 15               | I   | Negative differential battery current sense amplifier input                                |
| SRP                        | 16              | 16               | I/O | Positive differential battery current sense amplifier input                                |
| SRSET                      | 5               | 2                | I   | Battery charge current programming voltage                                                 |
| VCC                        | 22              | 22               | I   | Operational supply voltage                                                                 |
| VHSP                       | 20              | 20               | O   | Voltage source to drive gates of the external MOSFETs                                      |
| VREF                       | 7               | 4                | O   | Precision 5-V reference                                                                    |
| VS                         | 18              | 18               | I   | System (load) voltage input pin                                                            |

## PIN ASSIGNMENTS

**ACDET:** AC or adapter power detection. This input pin is used to determine the presence of the ac adapter. When the voltage level on the ACDET pin is less than  $V_{\text{ACPRES}}$ , the bq24702/bq24703 is in sleep mode, the PWM control is disabled, the  $\overline{\text{BATDRV}}$  is driven low, and the  $\overline{\text{ACDRV}}$  is driven high. This feature can be used to automatically select battery as the system power source.

**$\overline{\text{ACDRV}}$ :** AC or adapter power source select output. This pin drives an external P-channel MOSFET used to switch to the ac wall-adapter as the system power source. When the ACSEL pin is high while the voltage on the ACDET pin is greater than  $V_{\text{ACPRES}}$ , the output  $\overline{\text{ACDRV}}$  pin is driven low ( $V_{\text{HSP}}$ ). This pin is driven high ( $V_{\text{CC}}$ ) when the ACDET is less than  $V_{\text{ACPRES}}$ .

**ACN, ACP:** Negative and positive differential inputs, respectively for ac-to-dc adapter current sense resistor.

**ACPRES:** This open-drain output pin is used to indicate the presence of ac power. A logic high indicates there is a valid ac input. A low indicates the loss of ac power. ACPRES is high when the voltage level on the ACDET pin is greater than  $V_{\text{ACPRES}}$ .

**ACSEL:** AC adapter power select. This input selects either the ac adapter or the battery as the power source. A logic high selects ac power, while a logic low selects the battery.

**ACSET:** Adapter current programming voltage. This input sets the system current level at which dynamic power management occurs. Adapter currents above this programmed level activate the dynamic power management and proportionally reduce the available power to the battery.

**ALARM:** Depleted battery alarm output. This open-drain pin indicates that a depleted battery condition exists. A pullup on ALARM goes high when the voltage on the BATDEP pin is below  $V_{ACPRES}$ . On the bq24702, the ALARM output also activates when the selector inputs do not match the selector state.

**BATDEP:** Depleted battery level. A voltage divider network from the battery to BATDEP pin is used to set the battery voltage level at which depletion is indicated by the ALARM pin. See ALARM pin for more details. A battery depletion is detected when BATDEP is less than  $V_{ACPRES}$ . A no-battery condition is detected when the battery voltage is  $< 80\%$  of the depleted threshold. In a no-battery condition, the bq24702 automatically selects ac as the input source. If ENABLE = 1, the PWM remains enabled.

**BATDRV:** Battery power source select output. This pin drives an external P-channel MOSFET used to switch the battery as the system's power source. When the voltage level on the ACDET pin is less than  $V_{ACPRES}$ , the output of the BATDRV pin is driven low, GND. This pin is driven high ( $V_{CC}$ ) when ACSEL is high and ACDET  $> V_{ACPRES}$ .

**BATP:** Battery charge regulation voltage measurement input to the battery-voltage  $g_m$  amplifier. The voltage on this pin is typically derived from a voltage divider network connected across the battery. In a voltage loop, BATP is regulated to the  $V_{FB}$  precision reference of the battery voltage  $g_m$  amplifier.

**BATSET:** An external override to an internal precision reference. When BATSET is  $> 0.25$  V, the voltage level on the BATSET pin sets the voltage charge level. When BATSET  $\leq 0.25$  V, an internal  $V_{FB}$  reference is connected to the inverting input of the battery error amplifier. To ensure proper battery voltage regulation with BATSET, BATSET must be  $> 1.0$  V. Simply ground BATSET to use the internal reference.

**COMP:** The inverting input to the PWM comparator and output of the  $g_m$  amplifiers. A type II compensation network between COMP and GND is recommended.

**ENABLE:** Charge enable. A high on this input pin allows PWM control operation to enable charging while a low on this pin disables and forces the PWM output to a high state. Battery charging is initiated by asserting a logic 1 on the ENABLE pin.

**GND:** Supply return and ground reference

**IBAT:** Battery current differential amplifier output. The output of this pin produces a voltage proportional to the battery charge current. This voltage is suitable for driving an ADC input.

**PWM:** Gate drive output pin drives the P-channel MOSFET for PWM control. The PWM control is active when ACPRES, ACSEL, and ENABLE are high. PWM is driven low to  $V_{HSP}$  and high to  $V_{CC}$ .

**SRN, SRP:** Differential amplifier inputs for battery current sense. These pins feed back the battery charge current for PWM control. SRN is tied to the battery terminal. SRP is the source pin for zero volt operation.

**SRSET:** Battery charge current programmed voltage. The level on this pin sets the battery charge current limit.

**VCC:** Operational supply voltage.

**VHSP:** The VHSP pin is connected to a 1- $\mu$ F capacitor (close to the pin) to provide a stable voltage source to drive the gates of the external MOSFETs. VHSP = VCC – 10 V for VCC  $> 10.5$  V and VHSP = VCC – 0.5 V for VCC  $< 10.5$  V. A 13-V Zener diode should be placed between VCC and VHSP to prevent MOSFET overstress during start-up.

**VREF:** Bypassed precision voltage 5-V output. It can be used to set fixed levels on the inverting inputs of any one of the three error amplifiers if desired. The tight tolerance is suitable for charging lithium-ion batteries.

**VS:** System (Load) voltage input pin. The voltage on this pin indicates the system voltage in order to insure a break before make transition when changing from ac power to battery power. The battery is protected from an over-voltage condition by disabling the P-channel MOSFET connected to the BATDRV pin if the voltage at VS is greater than BATP. This function can be eliminated by grounding the VS pin.

## APPLICATION INFORMATION

### PROGRAMMING THE THRESHOLDS

The input-referenced thresholds for battery depleted, ac detection and charge voltage are defined by dimensioning the external dividers connected to pins BATDEP, ACDET and BATP. This calculation is simple, and consists of assuming that when the input voltage equals the desired threshold value the voltage at the related pin is equal to the pin internal reference voltage:

$$V_{\text{input}} = V_{\text{pin}} \times (1 + K_{\text{res}})$$

where:

$V_{\text{input}}$  = Target threshold, referenced to input signal

$V_{\text{pin}}$  = Internal reference (1.196 V for BATP; 1.246 V for BATDEP, ACDET)

$K_{\text{res}}$  = External resistive divider gain ( for instance:  $R_{24}/R_{25}$  for BATP)

When using external dividers with high absolute value the input bias currents for those pins must be included in the threshold calculation. On the bq24702/3 the input bias currents increase the actual value for the threshold voltage, when compared to the values calculated using the internal references and divider gain only:

$$V_{\text{input}} = V_{\text{pin}} \times (1 + K_{\text{res}}) + V_{\text{bias}}$$

The increase on the threshold voltage is given by:

$$V_{\text{bias}} = R_{\text{div}} \times I_{\text{pin}}$$

where:

$V_{\text{bias}}$  = Voltage increase due to pin bias current

$R_{\text{div}}$  = External resistor value for resistor connected from pin to input voltage

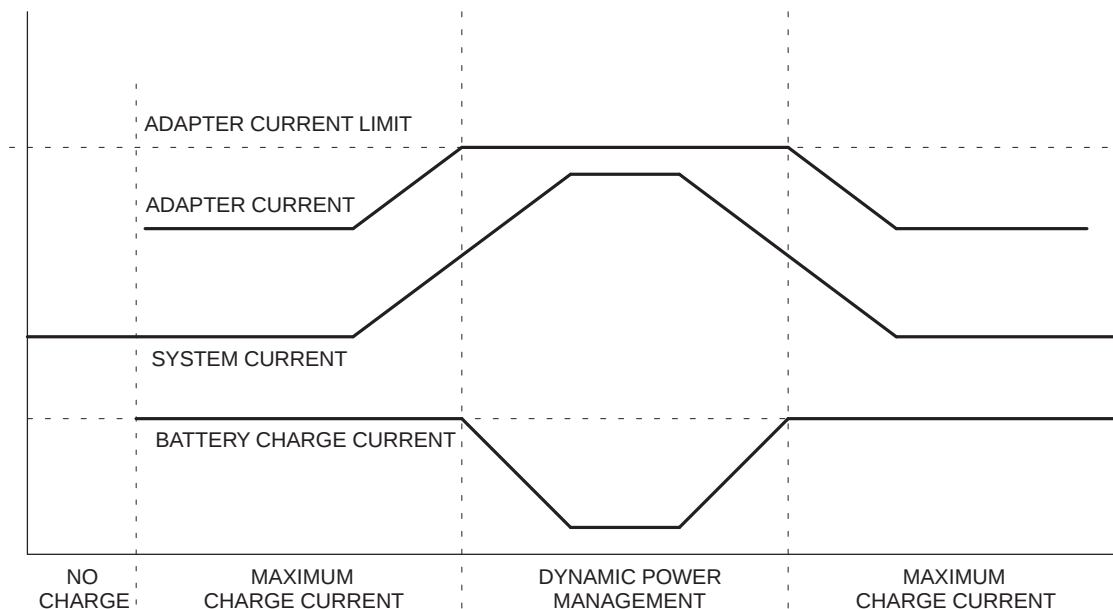
$I_{\text{pin}}$  = Maximum pin leakage current

The effect of IB can be reduced if the resistor values are decreased.

### DYNAMIC POWER MANAGEMENT

The dynamic power management (DPM) feature allows a cost effective choice of an ac wall-adaptor that accommodates 90% of the system's operating-current requirements. It minimizes battery charge time by allocating available power to charge the battery (i.e.  $I_{\text{BAT}} = I_{\text{ADPT}} - I_{\text{SYS}}$ ). If the system plus battery charge current exceeds the adapter current limit, as shown in [Figure 1](#), the DPM feature reduces the battery charge current to maintain an overall input current consumption within user defined power capability of the wall-adaptor. As the system's current requirements decrease, additional current can be directed to the battery, thereby increasing battery charge current and minimizing battery charge time.

The DPM feature is inherently designed into the PWM controller by inclusion of the three control loops, battery-charge regulation voltage, battery-charge current, and adapter-charge current, refer to [Figure 2](#). If any of the three user programmed limits are reached, the corresponding control loop commands the PWM controller to reduce duty cycle, thereby reducing the battery charge current.



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Figure 1. Dynamic Power Management

## ACDET OPERATION

The ACDET function senses the loss of adequate adapter power. If the voltage on ACDET drops below the internal  $V_{ACPRES}$  reference voltage, a loss of ADAPTER power is declared and the bq24702/bq24703 switches to battery power as the main system power. In addition, the bq24702/bq24703 shuts down its 5-V VREF and enters a low power sleep mode.

## BATTERY CHARGER OPERATION

The bq24702/bq24703 fixed-frequency, PWM controller is designed to provide closed-loop control of battery charge-current ( $I_{CH}$ ) based on three parameters, battery-float voltage ( $V_{BAT}$ ), battery-charge current, and adapter charge current ( $I_{ADPT}$ ). The bq24702/bq24703 is designed primarily for control of a buck converter using a high side P-channel MOSFET device (SW, refer to Figure 2).

The three control parameters are voltage programmable through resistor dividers from the bq24702/bq24703 precision 5-V reference, an external or internal precision reference, or directly via a DAC interface from a keyboard controller.

Adapter and battery-charge current information is sensed and fed back to two transconductance ( $g_m$ ) amplifiers via low-value-sense resistors in series with the adapter and battery respectively. Battery voltage information is sensed through an external resistor divider and fed back from the battery to a third  $g_m$  amplifier.

## PRECHARGE OPERATION

The precharge operation must be performed using the PWM regulator. The host can set the precharge current externally by monitoring the ALARM pin to detect a battery depleted condition and programming SRSET voltage to obtain the desired precharge current level.

## ZERO VOLT OPERATING

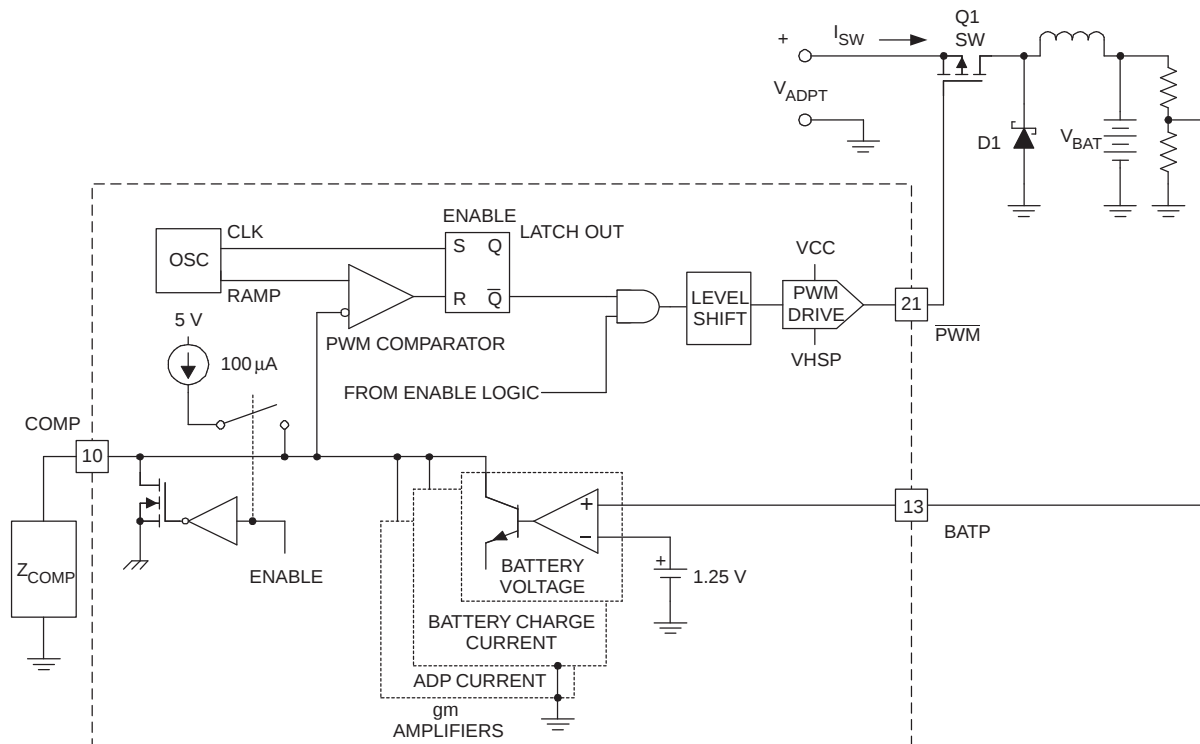
The zero volt operation is intended to provide a low current path to close open packs and protect the system in the event of a pack cell short-circuit condition or if a short is applied to the pack terminal. It is not designed to precharge depleted packs, as it is disabled at voltages that are not within normal pack operating range for precharge.

If the voltage at BATDEP pin is below the zero volt operation threshold, charge is enabled (EN=HI), and ac is selected (ACSEL=HI) the bq24702/3 enters the zero volt operation mode. When the zero volt operation mode is on, the internal PWM is disabled, and an internal power MOSFET connects SRP to  $V_{CC}$ . The battery charge current is limited by the filter resistor connected to SRP pin (R19). R19 must be dimensioned to withstand the worst case power dissipation when in zero volt operation mode.

The zero volt operation mode is disabled when BATDEP is above the zero volt operation threshold, and the main PWM loop is turned on if charge is enabled, regulating the current to the value set by SRSET voltage. To avoid errors on the charge current both resistors on the SRP, SRN filter must have the same value. Note, however, that R21 (connected to SRN) does not dissipate any power when in zero volt operation and can be of minimum size.

## PWM OPERATION

The three open collector  $g_m$  amplifiers are tied to the COMP pin (refer to Figure 2), which is internally biased up by a 100- $\mu$ A constant current source. The voltage on the COMP pin is the control voltage ( $V_C$ ) for the PWM comparator. The PWM comparator compares  $V_C$  to the sawtooth ramp of the internally fixed 300-kHz oscillator to provide duty cycle information for the PWM drive. The PWM drive is level-shifted to provide adequate gate voltage levels for the external P-channel MOSFET. Refer to *PWM selector switch gate drive* section for gate drive voltage levels.



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Figure 2. PWM Controller Block Diagram

## SOFTSTART

Softstart is provided to ensure an orderly start-up when the PWM is enabled. When the PWM controller is disabled (ENABLE = Low), the 100-μA current source pullup is disabled and the COMP pin is actively pulled down to GND. Disabling the 100-μA pullup reduces current drain when the PWM is disabled. When the bq24702/bq24703 PWM is enabled (ENABLE = High), the COMP pin is released and the 100-μA pullup is enabled (refer to Figure 2). The voltage on the COMP pin increases as the pullup charges the external compensation network connected to the COMP pin. As the voltage on the COMP pin increases the PWM duty cycle increases linearly as shown in Figure 3.

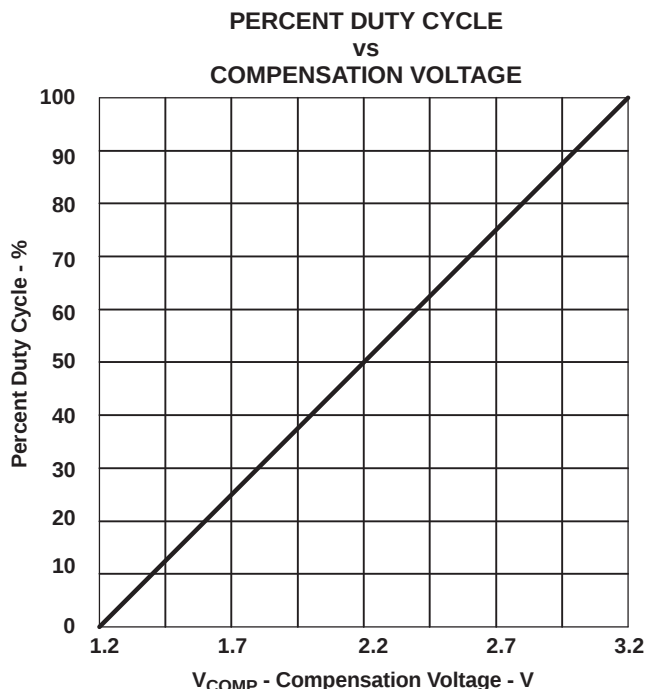


Figure 3.

As any one of the three controlling loops approaches the programmed limit, the  $g_m$  amplifier begins to shunt current away from the COMP pin. The rate of voltage rise on the COMP pin slows due to the decrease in total current out of the pin, decreasing the rate of duty cycle increase. When the loop has reached the programmed limit the  $g_m$  amplifier shunts the entire bias current (100 μA) and the duty cycle remains fixed. If any of the control parameters tries to exceed the programmed limit, the  $g_m$  amplifier shunts additional current from the COMP pin, further reducing the PWM duty cycle until the offending parameter is brought into check.

## SETTING THE BATTERY CHARGE REGULATION VOLTAGE

The battery charge regulation voltage is programmed through the BATSET pin, if the internal precision reference is not used. The BATSET input is a high-impedance input that is driven by either a keyboard controller DAC or via a resistor divider from a precision reference (see Figure 4).

The battery voltage is fed back to the  $g_m$  amplifier through a resistor divider network. The battery charge regulation voltage can be defined as:

$$V_{\text{BATTERY}} = \frac{(R1 + R2) \times V_{\text{BATSET}}}{R2} + I_{\text{BATP}} \times R1 \quad (1)$$

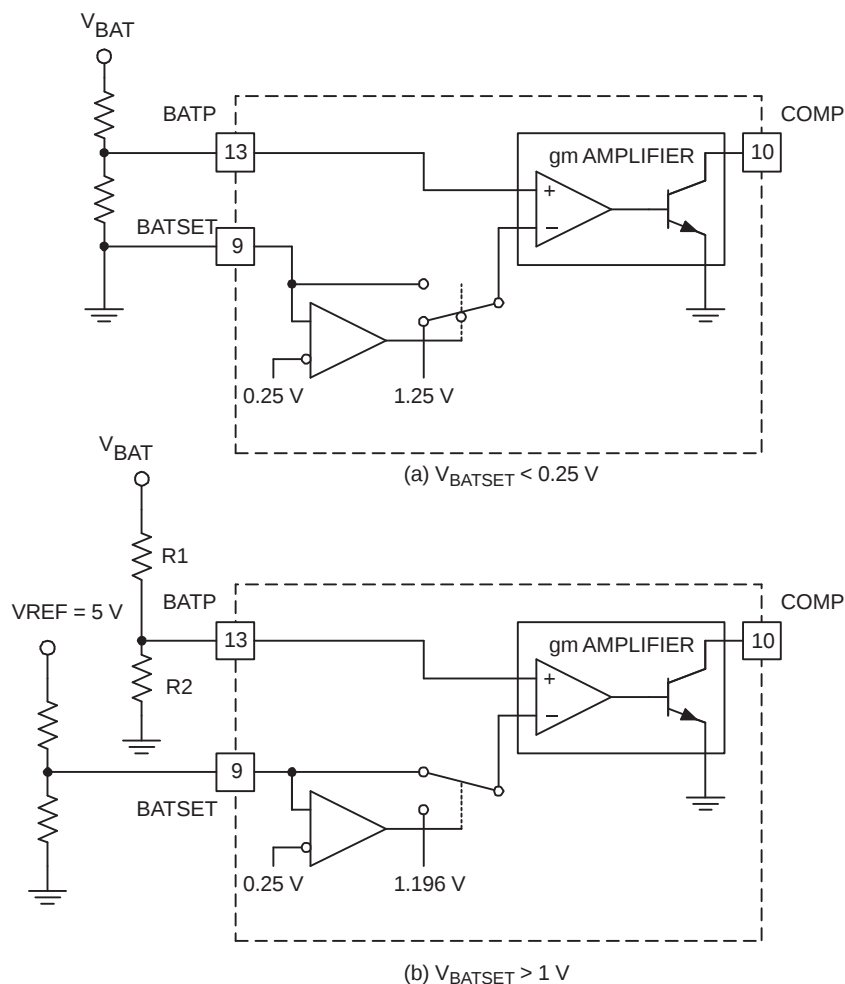
where  $I_{\text{BATP}}$  = input bias current for pin BATP

The overall accuracy of the battery charge regulation voltage is a function of the bypassed 5-V reference voltage tolerance as well as the tolerances on R1 and R2. The precision voltage reference has a 0.5% tolerance making it suitable for the tight battery voltage requirements of Li-ion batteries. Tolerance resistors of 0.1% are recommended for R1 and R2 as well as any resistors used to set BATSET.

The bq24702/bq24703 provides the capability of using an internal precision voltage reference through the use of a multiplexing scheme, refer to [Figure 4](#), on the BATSET pin. When BATSET voltage is less than 0.25 V, an internal reference is switched in and the BATSET pin is switched out from the  $g_m$  amplifier input. When the BATSET voltage is greater than 0.25 V, the BATSET pin voltage is switched in to the input of the  $g_m$  amplifier and the voltage reference is switched out.

**NOTE:**

The minimum recommended BATSET is 1.0 V, if BATSET is used to set the voltage loop.

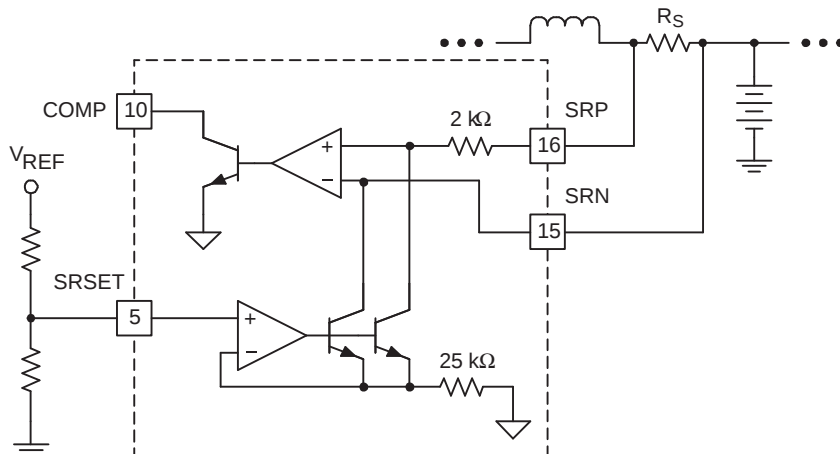


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**Figure 4. Battery Error Amplifier Input Multiplexing Scheme**

## PROGRAMMING THE BATTERY CHARGE CURRENT

The battery charge current is programmed via a voltage on the SRSET pin. This voltage can be derived from a resistor divider from the 5-V VREF or by means of an DAC. The voltage is converted to a current source that is used to develop a voltage drop across an internal offset resistor at one input of the SR  $g_m$  amplifier. The charge current is then a function of this voltage drop and the sense resistor ( $R_S$ ), refer to Figure 5.



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Figure 5. Battery Charge Current Input Threshold Function

The battery charge current can be defined as:

$$I_{BAT} = \frac{V_{SRSET}}{25 \times R_S} \quad (2)$$

where  $V_{SRSET}$  is the programming voltage on the SRSET pin.  $V_{SRSET}$  maximum is 2.5 V.

## PROGRAMMING THE ADAPTER CURRENT

Like the battery charge current described previously, the adapter current is programmed via a voltage on the ACSET pin. That voltage can either be from an external resistor divider from the 5-V VREF or from an external DAC. The adapter current is defined as:

$$I_{ADPT} = \frac{V_{ACSET}}{25 \times R_{S2}} \quad (3)$$

## COMPONENT SELECTION

### MOSFET Selection

MOSFET selection depends on several factors, namely, gate-source voltage, input voltage, and input current. The MOSFET must be a P-channel device capable of handling at least 15-V gate-to-source with a drain-source breakdown of  $V_{DS} \sim V_{IN} + 1$  V. The average input current can be approximated by:

$$I_{IN}(avg) = D \times I_{chg} \quad A$$

D = Duty cycle

$$I_{chg} = \text{Charge current} \quad (4)$$

The RMS current through the MOSFET is defined as:

$$I_{IN}(RMS) = I_{chg} \times \sqrt{D} \quad A_{RMS} \quad (5)$$

The rise/fall times for pin  $\overline{PWM}$  for the selected MOSFET should be greater than 40 nsec.

### Schottky Rectifier (Freewheeling)

The freewheeling Schottky rectifier must also be selected to withstand the input voltage,  $V_{IN}$ . The average current can be approximated from:

$$I_{D1}(avg) = I_{chg} \times (1 - D) \quad A \quad (6)$$

### Choosing an Inductance

Low inductance values result in a steep current ramp or slope. Steeper current slopes result in the converter operating in the discontinuous mode at a higher power level. Steeper current slopes also result in higher output ripple current, which may require a higher number or more expensive capacitors to filter the higher ripple current.

In addition, the higher ripple current results in an error in the sensed battery current particularly at lower charging currents. It is recommended that the ripple current not exceed 20% to 30% of full scale dc current.

$$L = \frac{D \times (V_{IN} - V_{BAT})}{F_S \times I_{chg} \times \text{Ripple}}$$

$$\text{Ripple} = \% \text{ Ripple allowed (Ex.: 0,2 for 20\% ripple)} \quad (7)$$

Too large an inductor value results in the current waveform of Q1 and D1 in [Figure 2](#) approximating a squarewave with an almost flat current slope on the step. In this case, the inductor is usually much larger than necessary, which may result in an efficiency loss (higher DCR) and an area penalty.

## Selecting an Output Capacitor

For this application the output capacitor is used primarily to shunt the output ripple current away from the battery. The output capacitor should be sized to handle the full output ripple current as defined as:

$$I_C \text{ (RMS)} = \frac{(V_{IN} - V_{BAT}) \times D}{F_S \times L} \quad A_{RMS} \quad (8)$$

## Selecting an Input Capacitor

The input capacitor is used to shunt the converter ripple current on the input lines. The capacitor(s) must have a ripple current (RMS) rating of:

$$I_{RMS} = \sqrt{[I_{chg} \times (1-D)]^2 \times D + [I_{chg} \times D]^2 \times (1-D)} \quad A_{RMS} \quad (9)$$

In addition to shunting the converter input ripple when the PWM is operating, the input capacitor also acts as part of an LC filter, where the inductance component is defined by the ac adapter cable inductance and board trace inductance from adapter connector to filter capacitor. Overshoot conditions can be observed at  $V_{CC}$  line during fast load transients when the adapter powers the load or when the adapter is hot-plugged.

Increasing the input capacitor value decreases the overshoot at  $V_{CC}$ . Avoid overshoot voltages at  $V_{CC}$  in excess of the absolute maximum ratings for that pin.

## Compensating the Loop

For the bq24702/bq24703 used as a buck converter, the best method of compensation is to use a Type II compensation network from the output of the transconductance amplifiers (COMP pin) to ground (GND) as shown in Figure 2. A Type II compensation adds a pole-zero pair and an additional pole at dc.

The Type II compensation network places a zero at

$$F_Z = \frac{1}{2} \times \left( \frac{1}{\pi \times R_{COMP} \times C_Z} \right) \text{ Hz} \quad (10)$$

and a pole at

$$F_P = \frac{1}{2} \times \left( \frac{1}{\pi \times R_{COMP} \times C_P} \right) \text{ Hz} \quad (11)$$

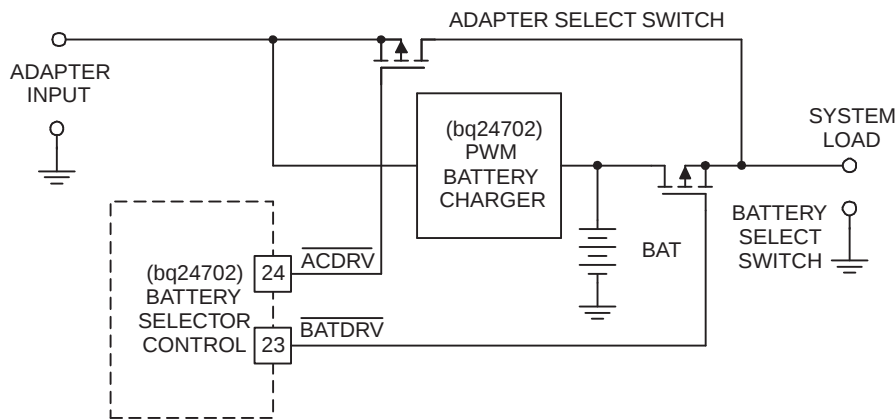
For this battery charger application the following component values:  $C_Z = 4.7 \mu\text{F}$ ,  $C_P = 150 \text{ pF}$ , and  $R_{COMP} = 100 \Omega$ , provides a closed loop response with more than sufficient phase margin, as long as the LC pole  $[1/2 \times \pi \times \sqrt{L \times C}]$  is set below 10 kHz. The SRP/SRN filter (R19, R21, C8) and ACP/ACN filter (R13/R15/C3) are required to filter noise associated with the PWM switching. To avoid adding secondary poles to the PWM closed loop system those filters should be set with cutoff frequencies higher than 1 kHz.

## SELECTOR OPERATION

The bq24702/bq24703 allows the host controller to manually select the battery as the system's main power source, without having to remove adapter power. This allows battery conditioning through smart battery learn cycles. In addition, the bq24702/bq24703 supports autonomous supply selection during fault conditions on either supply. The selector function uses low  $R_{DS(on)}$  P-channel MOSFETs for reduced voltage drops and longer battery run times.

### NOTE:

Selection of battery power whether manual or automatic results in the suspension of battery charging.



UDG-00119

**Figure 6. Selector Control Switches**

## AUTONOMOUS SELECTION OPERATION

Adapter voltage information is sensed at the ACDET pin via a resistor divider from the adapter input. The voltage on the ACDET pin is compared to an internally fixed threshold. An ACDET voltage less than the set threshold is considered as a loss of adapter power regardless of the actual voltage at the adapter input. Information concerning the status of adapter power is fed back to the host controller through ACPRES. The presence of adapter power is indicated by ACPRES being set high. A loss of adapter power is indicated by ACPRES going low regardless of which power source is powering the system. During a loss of adapter power, the bq24702/bq24703 obtains operating power from the battery through the body diode of the P-channel battery select MOSFET. Under a loss of adapter power, ACPRES (normally high) goes low, if adapter power is selected to power the system, the bq24702/bq24703 automatically switches over to battery power by commanding  $\overline{\text{ACDRV}}$  high and  $\overline{\text{BATDRV}}$  low. During the switch transition period, battery power is supplied to the load via the body diode of the battery select P-channel MOSFET. When adapter power is restored, the bq24702/bq24703 configures the selector switches according to the state of signals; ACSEL, and ACPRES. If the ACSEL pin is left high when ac power is restored, the bq24702/bq24703 automatically switches back to ac power. To remain on battery power after ac power is restored, the ACSEL pin must be brought low.

Conversely, if the battery is removed while the system is running on battery power and adapter power is present, the bq24702/bq24703 automatically switches over to adapter power by commanding  $\overline{\text{BATDRV}}$  high and  $\overline{\text{ACDRV}}$  low.

### NOTE:

For the bq24702 any fault condition that results in the selector MOSFET switches not matching their programmed states is indicated by the ALARM pin momentarily going high. Refer to Battery Depletion Detection Section for more information on the ALARM discrete.

When switching between the ac adapter and battery the internal logic monitors the voltage at pins  $\overline{\text{ACDRV}}$  and  $\overline{\text{BATDRV}}$  to implement a break-before-make function, with typical dead time on the order of 150 nsec.

The turnon times for the external ac/battery switches can be increased to minimize inrush peak currents; that can be accomplished by adding external resistors in series with the MOSFET gates (R18 and R26). Note, however, that adding those resistors effectively disables the internal break-before-make function for ac/battery-switches, as the MOSFET gate voltages can not be monitored directly. If external resistors are added to increase the rise/fall times for battery/ac switches the break-before-make has to be implemented with discrete external components, to avoid shoot-through currents between ac adapter and battery pack. This functionality can be implemented by adding diodes (D2/D9) that bypass the external resistors when turning off the external FETs.

## SMART LEARN CYCLES WHEN ADAPTER POWER IS PRESENT

Smart learn cycles can be conducted when adapter power is present by asserting and maintaining the ACSEL pin low. The adapter power can be reselected at the end of the learn cycle by a setting ACSEL to a logic high, provided that adapter power is present. Battery charging is suspended while selected as the system power source.

### NOTE:

On the bq24703 the ac adapter is switched to the load when the battery voltage reaches the battery depleted threshold; it can be used when the learn cycle does not require the battery voltage to go below the battery depleted threshold. If the learn cycle algorithm requires the battery voltage to go lower than the battery depleted voltage, the bq24702 should be used, as it does not switch the ac adapter to load upon battery depleted detection.

## SYSTEM BREAK BEFORE MAKE FUNCTION

When selecting the battery as the system primary power source, the adapter power select MOSFET turns off, in a *break-before-make* fashion, before the battery select MOSFET turns on. To ensure that this happens under all load conditions, the system voltage (load voltage) can be monitored through a resistor divider on the VS pin. This function provides protection against switching over to battery power if the adapter selector switch were shorted and adapter power present. Setting the VS resistive divider gain with the same gain selected for the BATP resistive divider assures the battery switch is turned on only when the system voltage is equal or less than the battery voltage. This function can be eliminated by grounding the VS pin.

The ACDET function senses the adapter voltage via a resistive divider (refer to application circuit). The divider can be connected either to the anode of the input blocking diode (directly to the adapter supply) or to the cathode of the input blocking diode (bq24702/3 VCC pin). When the divider is connected to the adapter supply, the adapter power removal is immediately identified and the sleep mode is entered, disabling the break-before-make function for system voltage (see section for system power switching) and coupling system voltage to the battery line. In normal operation with a battery present, the battery low impedance prevents any over-voltage conditions. However, if a pack is not present or the pack is open, the battery line voltage has a transient equal to the adapter voltage. The bq24703 SRP/SRN pins are designed to withstand this over-voltage condition, but avoid connection to the battery line of any external devices that are not rated to withstand the adapter voltage.

Connecting the ACDET resistive divider input to the VCC node keeps the system break-before-make function enabled until the voltage at pin VS is lower than the voltage at pin BATP. However, note that when using this topology the VCC pin voltage can be held by capacitive loads at either the VCC or system (ac switch is on) nodes when the ac adapter is removed. As the ACDET divider is connected to the VCC line there is a time delay from ac adapter removal to ac adapter removal detection by the IC. This time is dependent on load conditions and capacitive load values at VCC and system lines.

## BATTERY DEPLETION DETECTION

The bq24702/bq24703 provides the host controller with a battery depletion discrete, the ALARM pin, to alert the host when a depleted battery condition occurs. The battery depletion level is set by the voltage applied to the BATDEP pin through a voltage divider network. The ALARM output asserts high and remains high as long as the battery depletion condition exists, regardless of the power source selected.

For the bq24702, the host controller must take appropriate action during a battery depletion condition to select the proper power source. The bq24702 remains on the selected power source. The bq24703, however, automatically reverts over to adapter power, provided the adapter is present, during a deep discharge state. The battery is considered as being in a deep discharge state when the battery voltage is less than  $(0.8 \times \text{depleted level})$ .

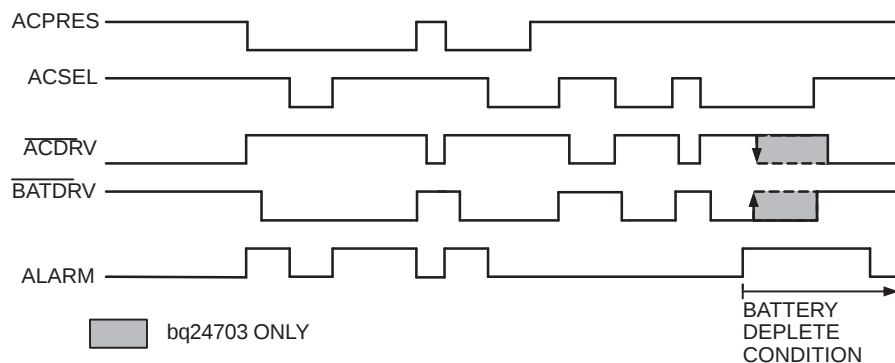
Feature sets for the bq24702 and bq24703 are detailed in the Available Options table.

**SELECTOR/ALARM TIMING EXAMPLE**

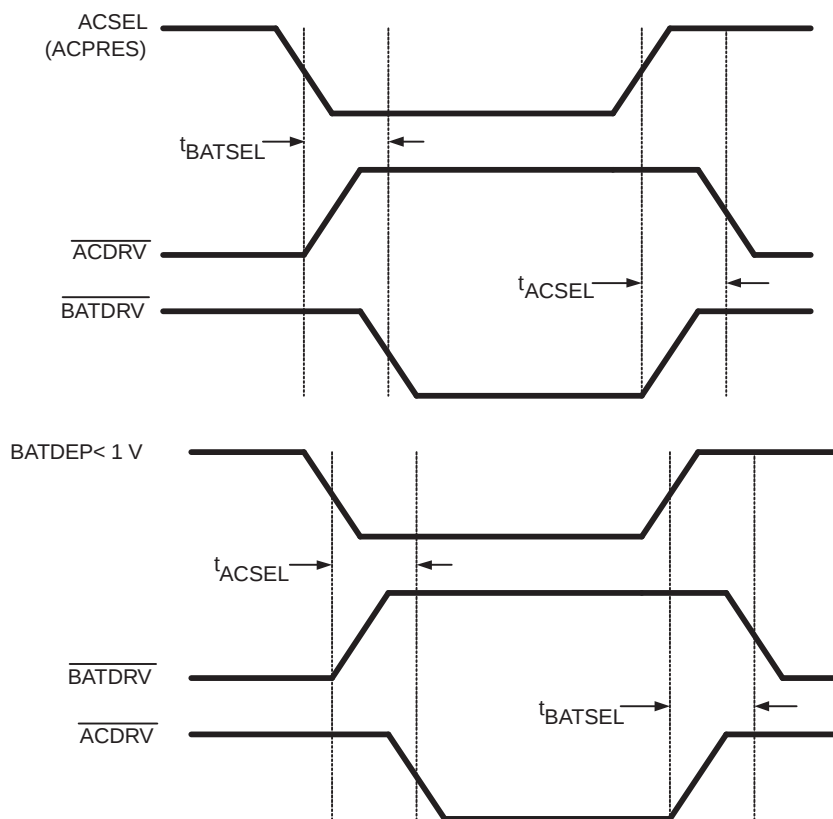
The selector and ALARM timing example in [Figure 7](#) illustrates the battery conditioning support.

**NOTE:**

For manual selection of wall power as the main power source, both the ACPRES and ACSEL signals must be a logic high.



UDG-00122



UDG-00120

**Figure 7. Battery Selector and ALARM Timing Diagram**

## PWM SELECTOR SWITCH GATE DRIVE

Because the external P-channel MOSFETs (as well as the internal MOSFETs) have a maximum gate-source voltage limitation of the input voltage, VCC, cannot be used directly to drive the MOSFET gate under all input conditions. To provide safe MOSFET-gate-drive at input voltages of less than an intermediate gate drive voltage rail was established (VSHP). Where  $V_{HSP} = VCC - 10\text{ V}$ . This ensures adequate enhancement voltage across all operating conditions.

An external zener diode (D3) connected between VCC and VHSP is required for transient protection; its breakdown voltage should be above the maximum value for internal VHSP/VCC clamp voltage for all operating conditions.

## TRANSIENT CONDITIONS AT SYSTEM, OVER-VOLTAGE AT SYSTEM TERMINAL

Overshoot conditions can be observed at the system terminal due to fast load transients and inductive characteristics of the system terminal to load connection. An overshoot at the system terminal can be directly coupled to the VCC and VBAT nodes, depending on the switch mode of operation. If the capacitors at VBAT and VCC can not reduce this overshoot to values below the absolute maximum ratings, it is recommended that an additional capacitor is added to the system terminal to avoid damage to IC or external components due to voltage overstress under those transient conditions.

## AC ADAPTER COLLAPSING DUE TO TRANSIENT CONDITIONS

The ac adapter voltage collapses when the ac switch is on and a current load transient at the system exceeds the adapter current limit protection. Under those conditions the ac switch is turned off when the ac adapter voltage falls below the ac adapter detection threshold. If the system terminal to load impedance has an inductive characteristic, a negative voltage spike can be generated at the system terminal and coupled into the battery line via the battery switch backgate diode.

In normal operation, with a battery present, this is not an issue, as the low battery impedance holds the voltage at battery line. However, if a battery is not present or the pack protector switches are open the negative spike at the system terminal is directly coupled to the SRP/SRN pins via the R19/R21 resistors.

Avoid damage to the SRP/SRN pins if this transient condition happens in the application. If a negative voltage spike happens at system terminal and R19/R21 limit the current sourced from the pin to less than  $-50\text{ mA}$  ( $I_{pin} = V_{system}/R19$ ), the pins SRP/SRN are not damaged and the external protection schottky diodes are not required. However, if the current under those transient conditions exceeds  $-50\text{ mA}$ , external schottky diodes must be added to clamp the voltage at pins SRP/SRN so they do not exceed the absolute maximum ratings specified ( $-0.3\text{ V}$ ).

## IBAT AMPLIFIER

A filter with a cutoff frequency smaller than  $10\text{ kHz}$  should be added to the IBAT output to remove switching noise.

## POWER DISSIPATION CALCULATION

During PWM operation, the power dissipated internally to the IC increases as the internal driver is switching the PWM FET on/off. The power dissipation figures are dependent on the external FET used, and can be calculated using the following equation:

$$P_{d(max)} = [I_{DDOP} + Q_g \times F_s(max)] \times V_{ADAP}$$

where:

$Q_g$  = Total gate charge for selected PWM MOSFET

$I_{DDOP}$  = Maximum quiescent current for IC

$V_{ADAP}$  = Maximum adapter voltage

$F_s(max)$  = Maximum PWM switching frequency

The maximum junction temperature for the IC must be limited to  $125^\circ\text{C}$ , under worst case conditions.

## TYPICAL CHARACTERISTICS

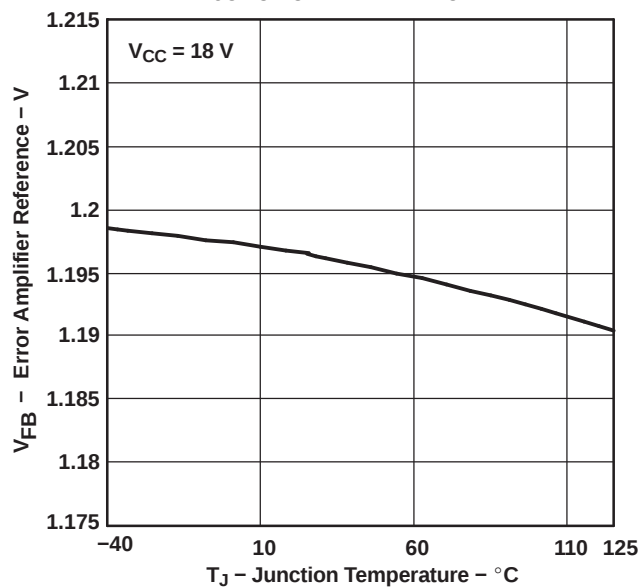
ERROR AMPLIFIER REFERENCE  
VS  
JUNCTION TEMPERATURE

Figure 8.

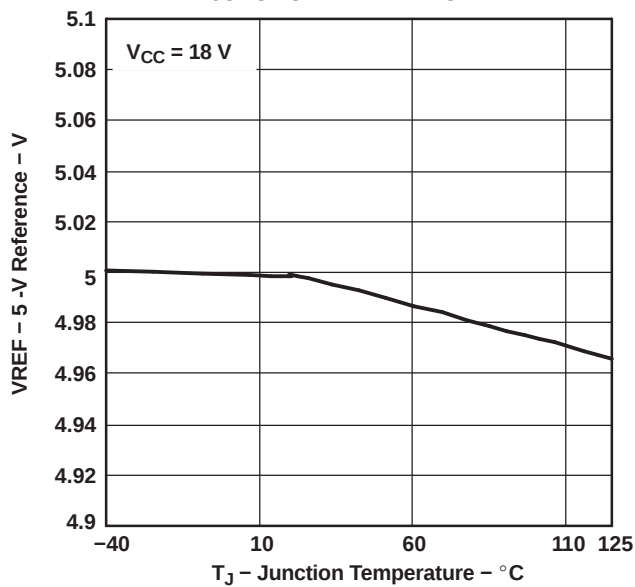
BYPASSED 5-V REFERENCE  
VS  
JUNCTION TEMPERATURE

Figure 9.

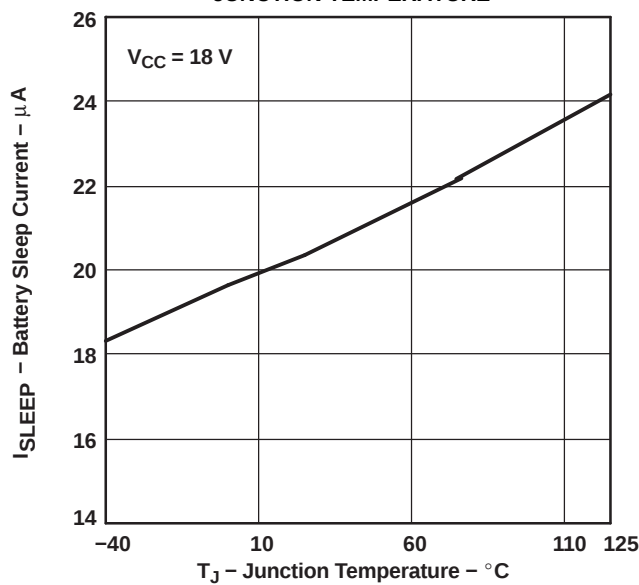
TOTAL SLEEP CURRENT  
VS  
JUNCTION TEMPERATURE

Figure 10.

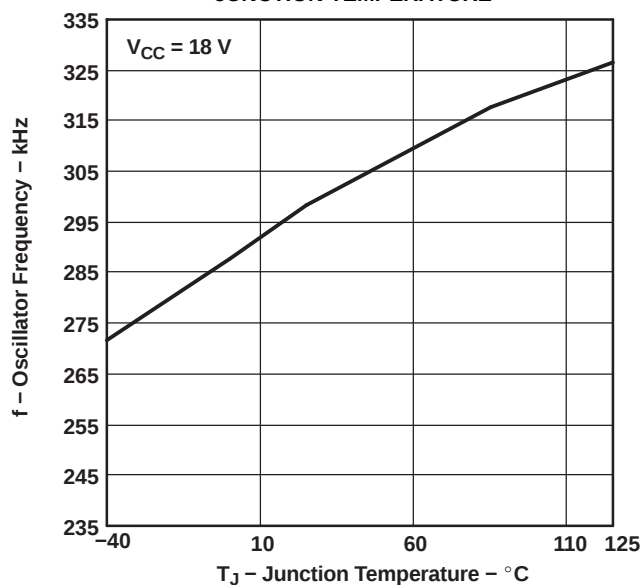
OSCILLATOR FREQUENCY  
VS  
JUNCTION TEMPERATURE

Figure 11.

## TYPICAL CHARACTERISTICS (continued)

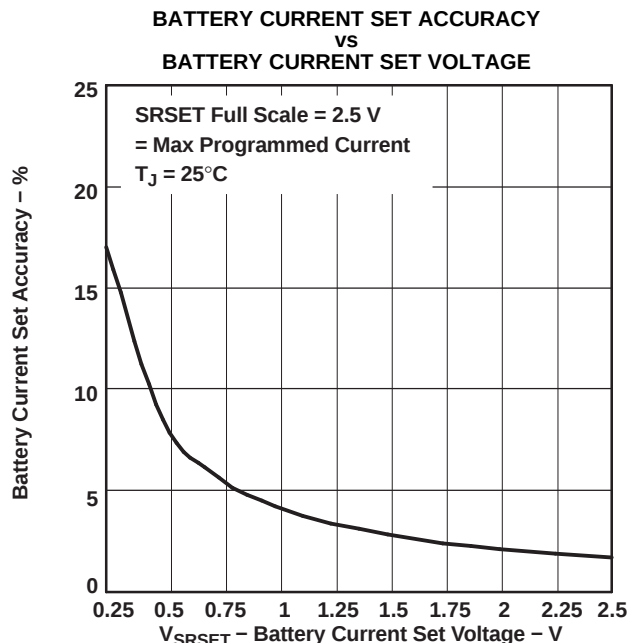


Figure 12.

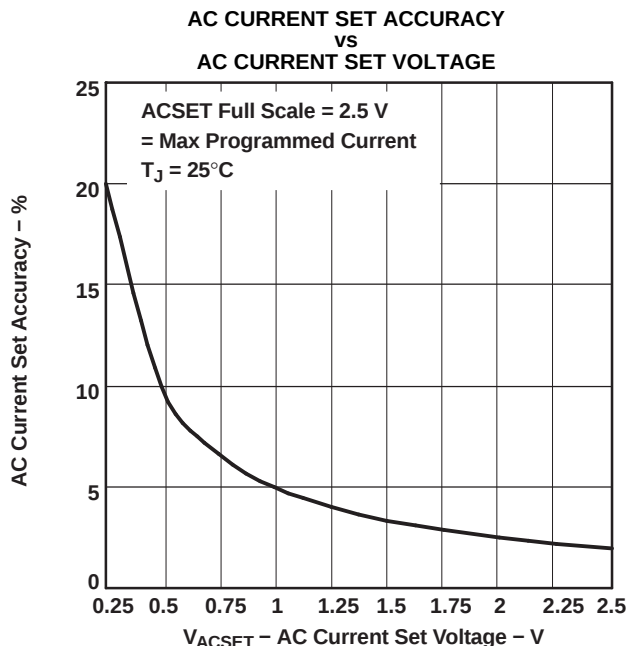


Figure 13.

## BOARD LAYOUT GUIDELINES

### Recommended Board Layout

Follow these guidelines when implementing the board layout:

1. Do not place lines and components dedicated to battery/adaptor voltage sensing (ACDET, BATDEP, VS), voltage feedback loop (BATP, BATSET if external reference is used) and shunt voltage sensing (SRP/SRN/ACP/ACN) close to lines that have signals with high dv/dt (PWM, BATDRV, ACDRV, VHSP) to avoid noise coupling.
2. Add filter capacitors for SRP/SRN (C8) and ACP/ACN (C3) close to IC pins
3. Add Reference filter capacitor C1 close to IC pins
4. Use an isolated, clean ground for IC ground pin and resistive dividers used in voltage sensing; use an isolated power ground for PWM filter cap and diode (C11/D4). Connect the grounds to the battery PACK- and adapter GND.
5. Place C7 close to VCC pin.
6. Place input capacitor C12 close to PWM switch (U3) source and R14.
7. Position ac switch (U2) to minimize trace length from ac switch source to input capacitor C12.
8. Minimize inductance of trace connecting PWM pin and PWM external switch U3 gate
9. Maximize power dissipation planes connected to PWM switch
10. Maximize power dissipation planes connected to SRP resistor if steady state in zero volt mode is possible
11. Maximize power dissipation planes connected to D1

## PACKAGING INFORMATION

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">BQ24702PW</a>   | Active        | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24702PW             |
| BQ24702PW.A                 | Active        | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24702PW             |
| BQ24702PWG4                 | Active        | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24702PW             |
| <a href="#">BQ24702PWR</a>  | Active        | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24702PW             |
| BQ24702PWR.A                | Active        | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24702PW             |
| <a href="#">BQ24703PW</a>   | Active        | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24703PW             |
| BQ24703PW.A                 | Active        | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24703PW             |
| <a href="#">BQ24703PWR</a>  | Active        | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24703PW             |
| BQ24703PWR.A                | Active        | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 24703PW             |
| <a href="#">BQ24703RHDR</a> | Active        | Production           | VQFN (RHD)   28 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | 24703               |
| BQ24703RHDR.A               | Active        | Production           | VQFN (RHD)   28 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | 24703               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| BQ24703RHDR | VQFN         | RHD             | 28   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

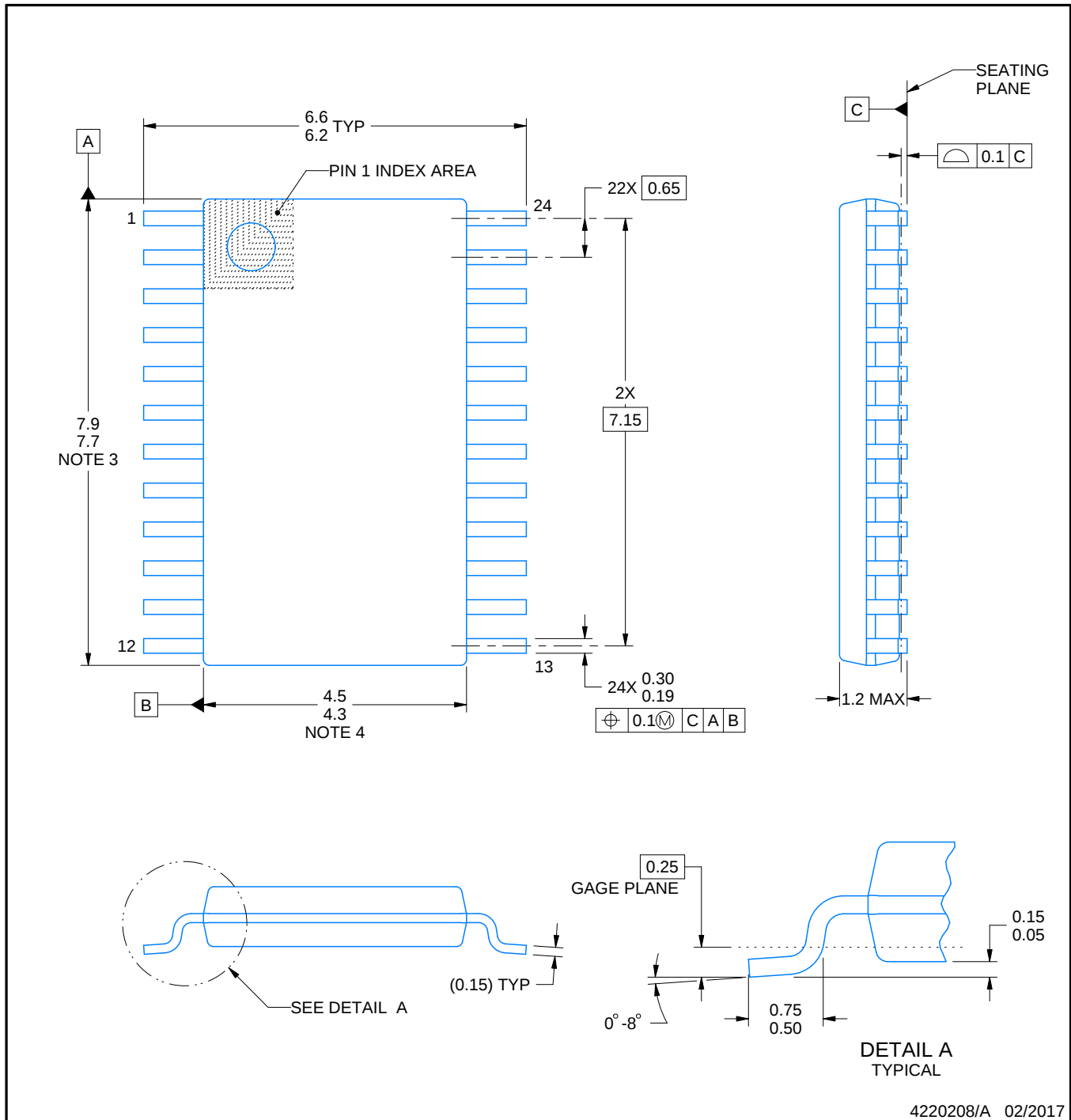
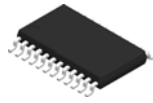
| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| BQ24703RHDR | VQFN         | RHD             | 28   | 3000 | 353.0       | 353.0      | 32.0        |

## TUBE



\*All dimensions are nominal

| Device      | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| BQ24702PW   | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |
| BQ24702PW.A | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |
| BQ24702PWG4 | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |
| BQ24703PW   | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |
| BQ24703PW.A | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |



4220208/A 02/2017

## NOTES:

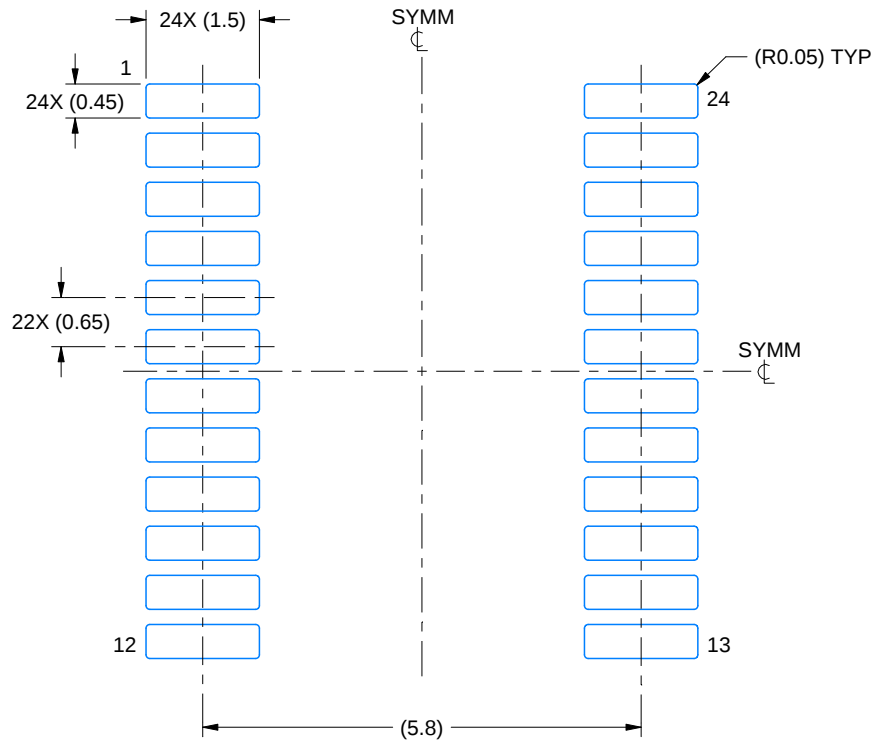
- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

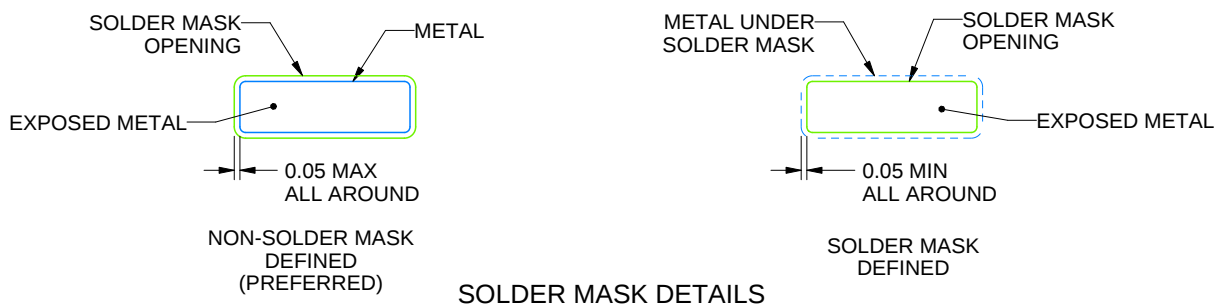
PW0024A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220208/A 02/2017

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

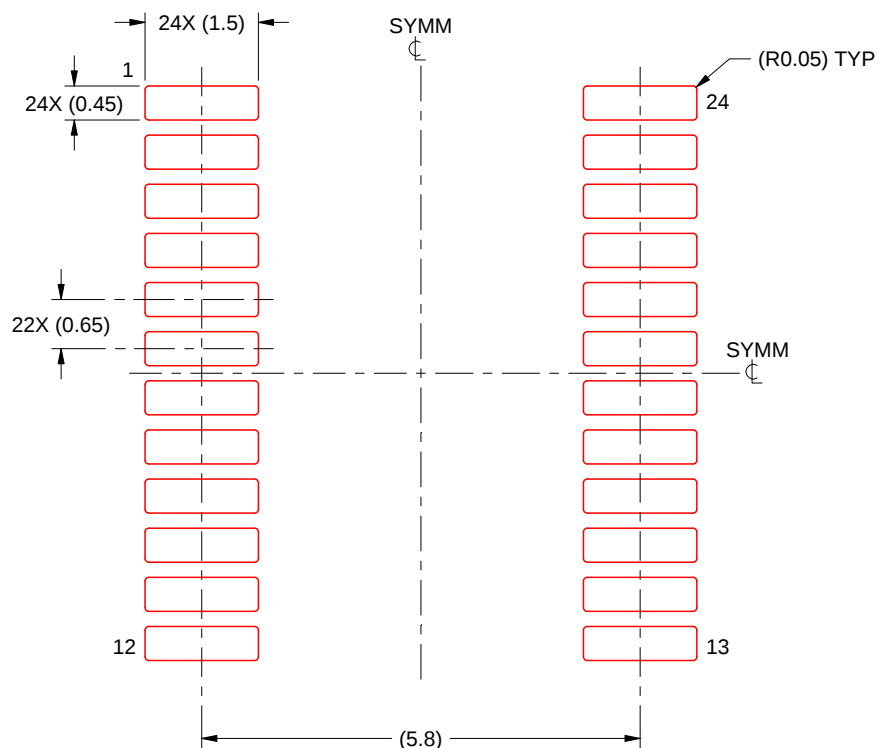
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0024A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220208/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

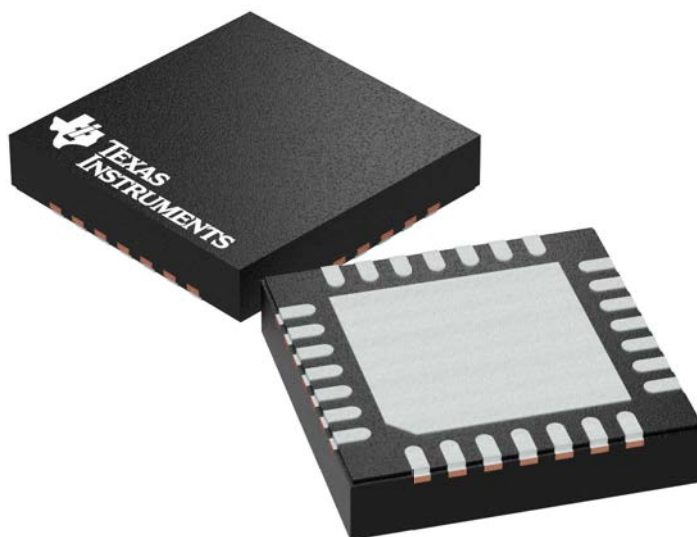
## GENERIC PACKAGE VIEW

**RHD 28**

**VQFN - 1 mm max height**

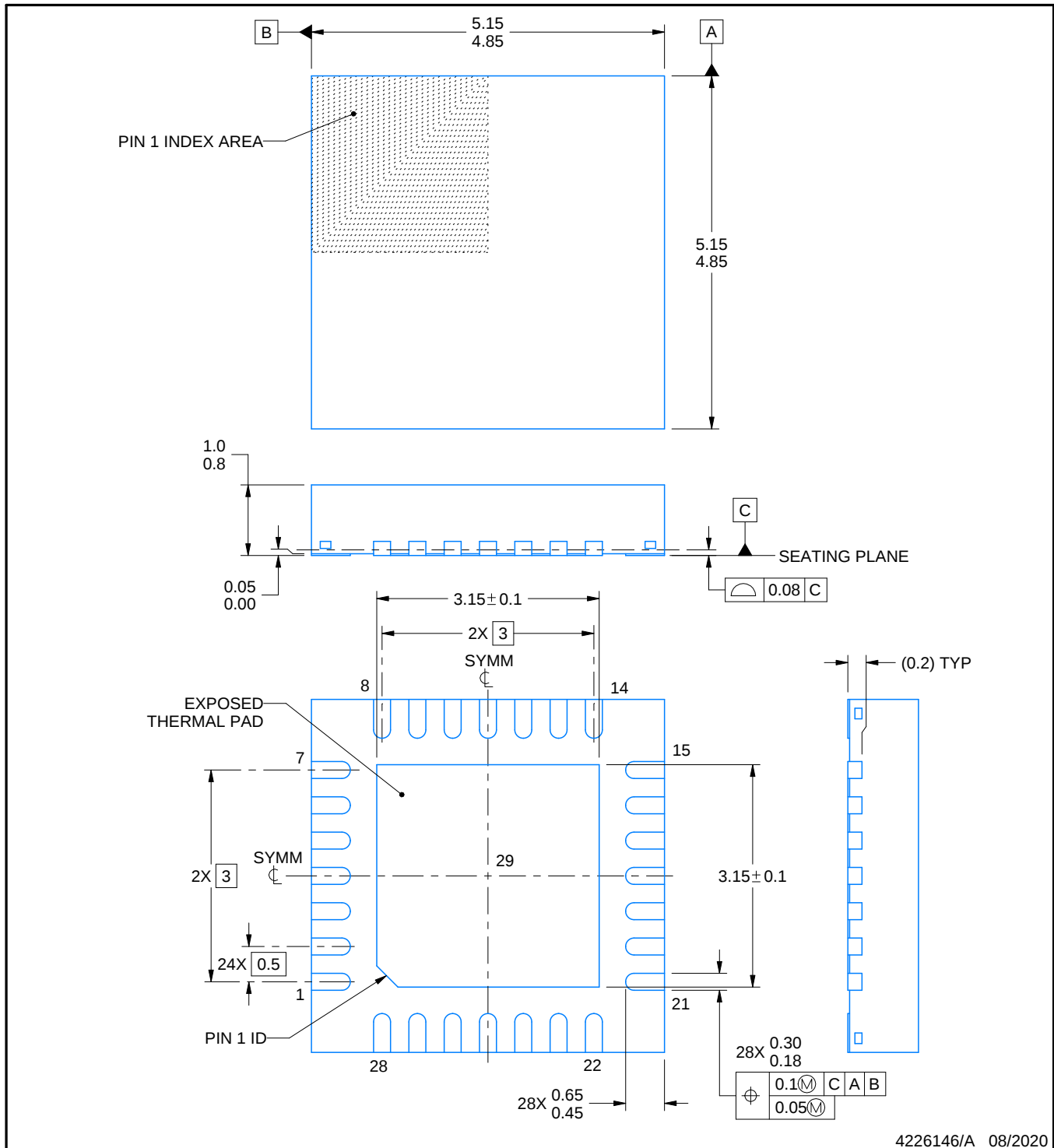
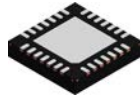
5 x 5 mm, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4204400/G



4226146/A 08/2020

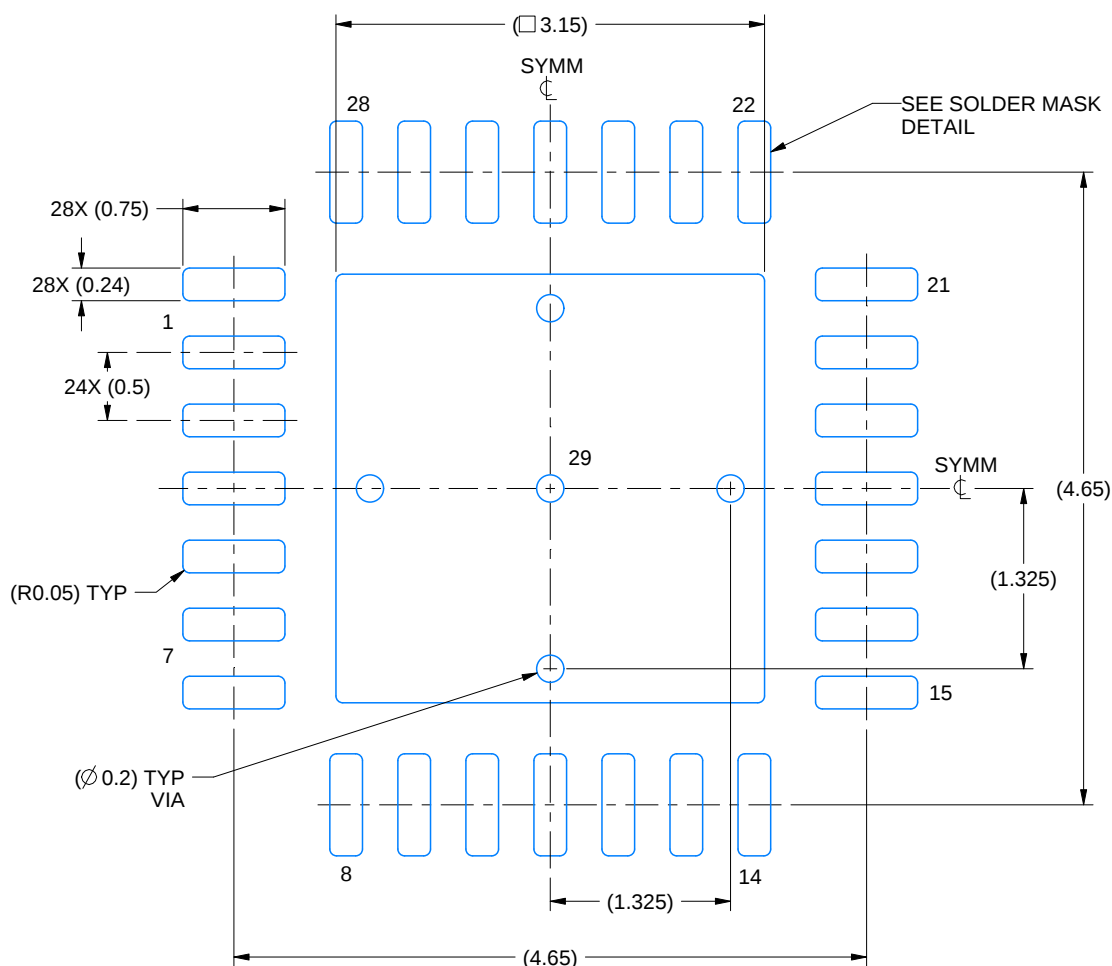
## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

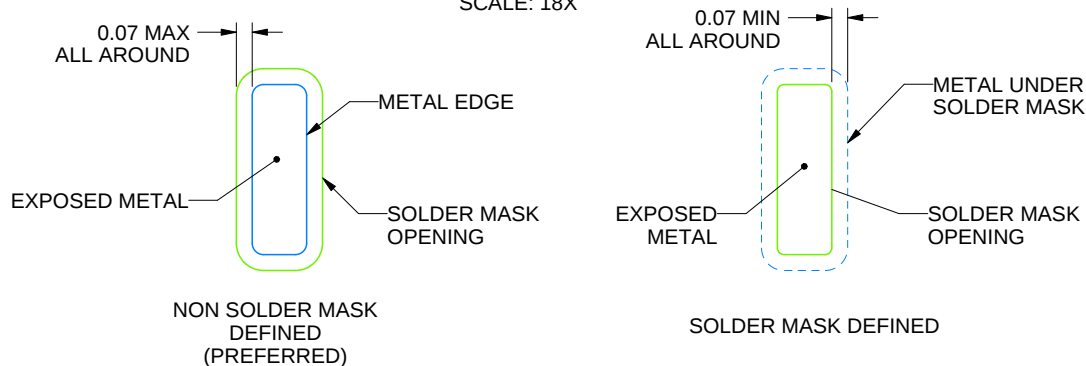
**RHD0028B**

### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 18X



## SOLDER MASK DETAILS

4226146/A 08/2020

NOTES: (continued)

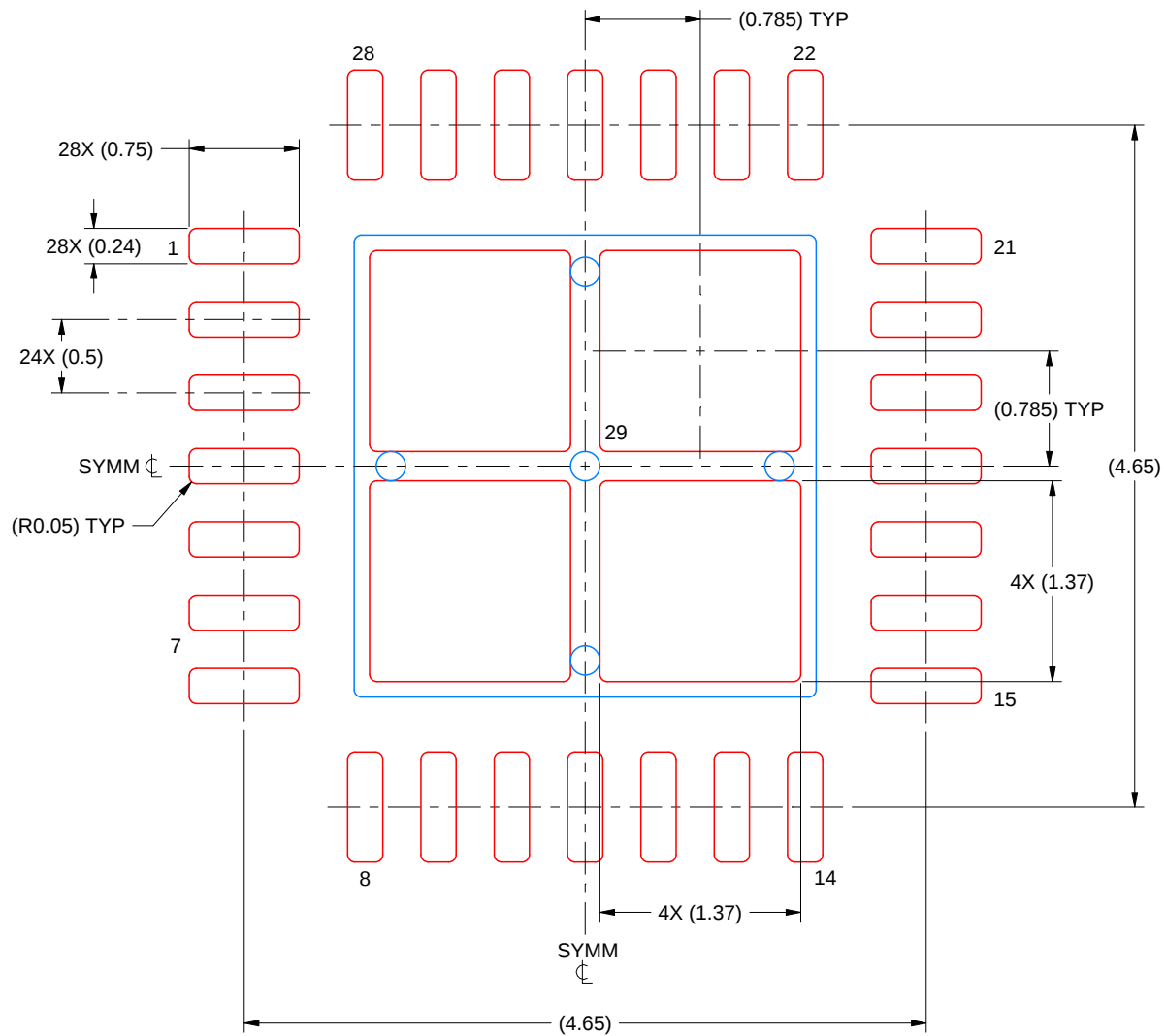
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RHD0028B

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 MM THICK STENCIL  
SCALE: 20X

EXPOSED PAD 29  
76% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

4226146/A 08/2020

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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